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Electron Source based on Superconducting RF

A Dissertation Presented

by

Tianmu Xin

to

The Graduate School

in Partial Fulfillment of the

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Abstract of the Dissertation

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High-bunch-charge photoemission electron-sources operating in a Continuous Wave (CW) mode can provide high peak current as well as the high average current which are required for many advanced applications of accelerators facilities, for example, electron coolers for hadron beams, electron-ion colliders, and Free-Electron Lasers (FELs).

Superconducting Radio Frequency (SRF) has many advantages over other electron-injector technologies, especially when it is working in CW mode as it offers higher repetition rate. An 112 MHz SRF electron photo-injector (gun) was developed at Brookhaven National Laboratory (BNL) to produce high-brightness and high-bunch-charge bunches for electron cooling experiments. The gun utilizes a Quarter-Wave Resonator (QWR) geometry for a compact structure and improved electron beam dynamics. The detailed RF design of the cavity, fundamental coupler and cathode stalk are presented in this work. A GPU accelerated code was written to improve the speed of simulation of multipacting, an important hurdle the SRF structure has to overcome in various locations.

The injector utilizes high Quantum Efficiency (QE) multi-alkali photocathodes (K_2CsSb) for generating electrons. The cathode fabrication system and procedure are also included in the thesis.

Beam dynamic simulation of the injector was done with the code ASTRA. To find the optimized parameters of the cavities and beam optics, the author wrote a genetic algorithm Python script to search for the best solution in this high-dimensional parameter space.

The gun was successfully commissioned and produced world record bunch charge and average current in an SRF photo-injector.

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Introduction

The high peak and average current electron injector with good emittance is of great importance in the next generation light source (FEL driven) [1], high-energy electron coolers [2, 3], and essentially all the facilities that require high brightness and high average power electron beams.

In this work we present the design, building and commissioning of a Superconducting Radio Frequency (SRF) electron injector with a high Quantum Efficiency (QE) multi-alkali photocathode [4] that is capable of providing electron beams with better than 7.5 mm-mrad transverse emittance, energy spread smaller than 5×10^{-3} and bunch charge as large as 3 nC. The injector consists of several critical parts including the 112 MHz SRF cavity, the coaxial type Fundamental Power Coupler (FPC), the half wavelength choke structure cathode stalk with cathode insertion system and high quantum efficiency multi-alkali photocathode.

The 112 MHz quarter wave resonator cavity was designed, built and tested in previous work [5]. We took it as the base of the new injector for the Coherent Electron Cooling (CeC PoP) experiment. Although the major part of RF design of the cavity has been done years before the design of this injector [6], there were still critical items to be designed and resolved. As examples we can mention the multipacting (MP) study, Lorentz detuning, mechanical tuning sensitivity and detuning due to helium pressure change. Furthermore, there were essential subsystems of the injector to be designed, constructed and commissioned, such as the Fundamental Power Coupler (FPC), the coarse tuner and the photocathode insertion system. All these elements are critical for making the cavity usable as an injector, and will be discussed in more details later.

The coaxial type of Fundamental Power Coupler (FPC) is designed to provide up to 780-W power to the electron bunches [7]. Besides the main role of a power coupler the FPC can also be used as a fine tuner of the injector to adjust the frequency more precisely compare to the mechanical tuner. With the help of the commercial computer simulation codes CST and ANSYS, the author performed the RF simulation and thermal analysis of the FPC. The multipacting issue of the FPC was a major concern when we were

considering the coaxial structure. Both GPU code, which was developed by the author for the MP simulation and the ACE3P [8] code were used. Simulation results provided information on the RF voltage levels, locations and strength of the multipacting, and suggested the possibility of easing the problem with gold coating, which has a lower secondary electron yield as compared to pure copper. Moreover, the gold coating provides smaller emissivity, 50% better than copper and the forty times better than the oxidized copper which means proportionally less radiation thermal load to the cryosystem.

In order to simplify the photocathode insertion system, we had to find a way to insert the cathode into the cavity, which is at 4.5 K, without cooling the cathode to the same temperature. In addition, according to recent work done by E. Wang and H. Xie at BNL, the quantum efficiency of K_2CsSb cathode at 532 nm will drop substantially at cryogenic temperatures [9], adding to the incentive of keeping the cathode warm. A choke-joint structure is a natural choice for the implementation of this design, thanks to its capability to provide an electrical short at the cavity side of the insert and yet to provide thermal isolation [10]. A half wavelength choke-joint cathode stalk was designed to hold the cathode in the desired position inside the cavity. Impedance mismatch was implemented to further reduce the impedance of the stalk seen by the cavity. The thermal and multipacting issues in the cathode insertion system were also investigated intensively, as in the FPC case. The gold coating solved the problems according to the simulation, and the details are discussed in Chapter 4. The heart of the injector, where everything starts from, is the cathode. The performance of the cathode sets the ultimate quality of the beam downstream. We decided to use the multi-alkali (K_2CsSb) photocathode for its high quantum efficiency under green light and acceptable vacuum tolerance. The recipe of fabricating K_2CsSb has been well developed [11], and we adopted it with some modifications aimed at improving its performance in our system.

To investigate the multipacting phenomenon in the SRF structure, the author developed a 3D particle tracking code with C language, which utilizes Graphic Processor Unit (GPU) acceleration. The code tracks the electrons in tetrahedral mesh elements under the pre-calculated electromagnetic (EM) field. The unique feature of the code is that it takes

advantage of the high concurrency of the GPU and updates coordinates of thousands of particle in 6-D phase space (three spatial plus three momentum) simultaneously. By parallelizing the most time-consuming parts of the algorithm the execution time of the GPU version of the code can be five times faster than the CPU version on a Nvidia Tesla K40. A detailed discussion can be found in Chapter 2.

Another important element of the design and commissioning of the injector is the beam dynamics simulation. Since this is a multi-parameter multi-objective optimization problem, the author decided to solve it by using a genetic algorithm. A python script was written to search for the combination of operating parameters that meets the requirement of the experiment. Simulation results given by ASTRA [12] show that the injector is capable of generating 2 nC/bunch beam with better than 7.5 mm-mrad transverse emittance and 0.5% energy spread.

A special type of cathode, Diamond Amplifier, is discussed in Chapter 7 of the thesis. We designed the housing components of the amplifier integrated with the primary cathode holder [13]. The laser optics and electron transport of the primary electron beam were tested in a chamber independent of the SRF injector. The result of the preliminary test is promising. If we have the opportunity to test the amplifier in an SRF injector in future, we should be able to demonstrate the great potential of the diamond amplifier in high peak/average current injector.

The electron injector driven by 112 MHz QWR SRF cavity and K_2CsSb cathode has been tested for the first time at BNL during the RHIC run 15, namely from the December 2014 to June 2015. We were able to extract a world record bunch charge and average current for a superconducting electron gun to date. The injector delivered up to 3 nC/bunch electron with a repetition rate as high as 5 kHz (limited by laser system at the time), leading to an average current of 15 μA .

1 The Design and Fabrication of the 112 MHz QWR SRF Cavity

1.1 Cavity Design

A careful design of the electron gun is the key to the good performance of any electron accelerator. The electron bunch leaves the surface of the cathode and gains the initial energy boost within this device. The critical issue that requires careful consideration is the form of the electromagnetic field regarding both the time and spatial structure. The simplest choice is to use the DC Pierce shape electrode [14]. However, the DC approach is limited by surface field strength which consequently limits the current density one can extract from the cathode. Furthermore, to minimize emittance growth, a rapid acceleration of the electrons is necessary. Therefore, we chose to use an RF cavity instead. Furthermore, to get a CW operating beam we decided to use a superconducting quarter wave cavity operating at 112 MHz frequency. The 112 MHz quarter wave resonator (QWR) cavity was mainly designed in previous work of Xiangyun Chang. For the sake of completeness of the story, we will briefly recapitulate the work and considerations during the design of cavity.

To get a high bunch charge and maintain a good emittance, one needs to mitigate the space charge limitation which means using a high electric field on the cathode surface. The typical surface gradient that a DC structure can provide is in the range of 5 to 10-MV/m [15], which is limited by the discharging phenomenon from the field emission tips on the electrode. However, an RF structure can easily provide a much higher field gradient on the cathode surface. For a superconducting cavity the field strength can be around 20 to 30 MV/m [16, 17] and for a pulsed normal conducting cavity the field level can be even as high as 100 MV/m [18]. The disadvantage of a normal conducting cavity, typically made of high purity copper, is that this kind of cavity can only run at a relatively low duty factor, which will have a large negative impact on the average current.

Considering the injector's frequency, reducing the peak current density also helps in getting a higher bunch charge. The 112 MHz cavity has a much lower frequency than a traditional SRF cavity (for example the Tesla 1.3 GHz cavity [19]) which means the bunch length (typically in the order of 10 degrees of the RF cycle) can be much longer, hence reduce the current density linearly. For a cavity with such a low frequency, the

elliptical shape cavity is no longer the optimum choice due to its large diameter, and this is the reason we chose quarter wave resonator instead.

To increase the average current once the bunch charge is limited by the achievable strength of the surface field, the most straightforward way is to increase the repetition rate of the bunch. That is best done by delivering the beam in a Continuous Wave (CW) mode, which means that ultimately each RF cycle can support one bunch so that the average current of the beam can be maximized. As we mentioned before, the traditional normal conducting cavity at a high RF field can only work under pulsed mode with a duty factor low enough so that the thermal load to the structure and peripheral devices can be handled. Hence, the normal conducting cavity, with very few exemptions [20], cannot provide a CW beam. This is where the superconducting cavity shines since it generates as much as six orders of magnitude lower RF power dissipation compared to a normal conducting cavity at the same frequency [17]. This makes it clear that the SRF cavity is a very strong candidate for high bunch charge high average current electron injector.

Taking all the factors into account, we eventually decided to use the 112 MHz QWR SRF cavity as the electric field generating cavity of the injector.

Here we briefly introduce the key parameters of an SRF cavity, namely the frequency, quality factor, geometry factor, R/Q , B_{\max}/E_{acc} , E_{\max}/E_{acc} , and transit time factor.

1.1.1 The frequency of the RF Resonator.

One of the most common RF cavity people use as a model is the so-called pillbox cavity model [21]. The typical shape of the cavity is shown in Figure 1-1. The equation of the EM field in such a structure can be written as the following.

Starting from the basic Maxwell's equations

$$\begin{aligned}\nabla \cdot E &= \frac{\rho}{\epsilon_0}, \\ \nabla \times E &= -\frac{\partial B}{\partial t}, \\ \nabla \cdot B &= 0,\end{aligned}\tag{1-1}$$

$$\nabla \times B = \mu_0 J + \frac{1}{c^2} \frac{\partial E}{\partial t},$$

where ρ is the charge density in unit of C/m³, ϵ_0 is the vacuum permittivity equal to 8.854×10^{-12} F/m in SI unit, μ_0 is the vacuum permeability equals to $4\pi \times 10^{-7}$ H/m in SI unit and J is the current density in unit of A/m².

Consider the free space case and take the curl of the second equation above,

$$\nabla \times (\nabla \times E) = \nabla \times (\nabla \cdot E) - \nabla^2 E = -\frac{\partial}{\partial t} (\nabla \times B),$$

$$\nabla^2 E - \frac{1}{c^2} \frac{\partial E}{\partial t} = 0.$$

Similarly for the magnetic part,

$$\nabla^2 B - \frac{1}{c^2} \frac{\partial B}{\partial t} = 0.$$

Now we got the famous EM wave equations. Assuming the harmonic time dependence of EM field $e^{-i\omega t}$, where ω is the angular frequency of the oscillation, we can get

$$\left(\nabla^2 + \frac{\omega^2}{c^2}\right) \begin{pmatrix} E \\ B \end{pmatrix} = 0, \quad (1-2)$$

where c is the speed of light in vacuum.

In a cylindrical geometry, following the approach Jackson chose in his book [22] we can separate the transverse and longitudinal parts of the fields as the following,

$$\begin{aligned} E &= E(x, y)e^{\pm ikz - i\omega t}, \\ B &= B(x, y)e^{\pm ikz - i\omega t}, \end{aligned} \quad (1-3)$$

with k representing the wave number defined as $k = \frac{2\pi}{\lambda}$, where λ is the wave length of the EF field.

Hence, we can write the wave equation as

$$(\nabla_t^2 + \frac{\omega^2}{c^2} - k^2) \begin{pmatrix} E \\ B \end{pmatrix} = 0, \quad (1-4)$$

where $\nabla_t^2 = \nabla^2 - \frac{\partial^2}{\partial z^2}$, if we further decompose the field into transverse and longitudinal components in explicit way we will get,

$$\vec{E} = \vec{E}_t + \vec{E}_z; \vec{B} = \vec{B}_t + \vec{B}_z.$$

Substituting this form of field into the equation (1-1) we can get the relation between the transverse and the longitudinal field as

$$E_t = \frac{i}{\frac{\omega^2}{c^2} - k^2} [k\nabla_t E_z - \omega \hat{z} \times \nabla_t B_z],$$

$$B_t = \frac{i}{\frac{\omega^2}{c^2} - k^2} [k\nabla_t B_z + \frac{\omega}{c^2} \hat{z} \times \nabla_t E_z], \quad (1-5)$$

where \hat{z} is the unit vector in z direction.

For the TM mode, which is the common accelerating mode, we have $B_z = 0$ everywhere. Hence,

$$E_t = \frac{i}{\frac{\omega^2}{c^2} - k^2} [k\nabla_t E_z],$$

$$B_t = \frac{i}{\frac{\omega^2}{c^2} - k^2} \left[\frac{\omega}{c^2} \hat{z} \times \nabla_t E_z \right]. \quad (1-6)$$

In a pillbox cavity, we can write the longitudinal electric field as

$$E_z = \psi(r) e^{\pm ikz - im\phi}, \quad (1-7)$$

with $k = p \frac{\pi}{d}$, $p = 0, 1, 2, 3 \dots$, ϕ as the azimuthal angle in cylindrical coordinate, and d is the length of the pillbox cavity in z direction.

Then from equation (1-6) we can get the new equation for the r dependent part of E_z as

$$\left(\frac{1}{r} \frac{d}{dr} r \frac{d}{dr} - \frac{m^2}{r^2} + \gamma^2\right) \psi = 0. \quad (1-8)$$

In a cylindrical coordinate with boundary condition $\psi(r = a) = 0$ we have the following solutions

$$\psi = E_0 J_m(\kappa r), \quad (1-9)$$

where J_m is m^{th} order Bessel function. For the fundamental mode we have

$$\omega = c\kappa = \frac{c j_{0,1}}{a} = \frac{2.4048 c}{a}, \quad (1-10)$$

where $j_{0,1}$ is the first zero point of zeroth order Bessel function which is 2.4048 and a is the radius of the pillbox cavity.

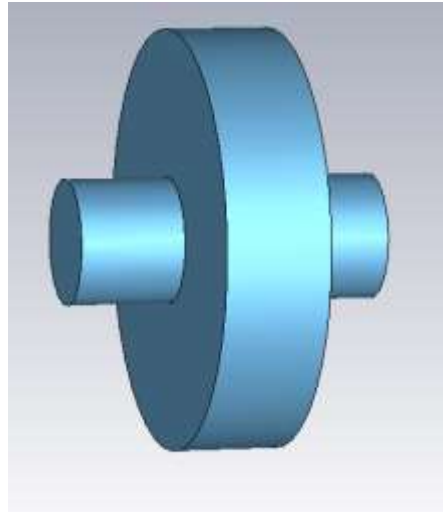


Figure 1-1. Pillbox cavity, showing only the volume of vacuum.

As we can see, the fundamental mode frequency of the pillbox type cavity is directly related to the transverse size of the cavity. If we would like to build a cavity which works at a frequency $f = 100$ MHz, the radius of the cavity would be in the order of 1.15 m which could be quite difficult to handle. Hence we need the so-called TEM mode cavity when looking into the low frequency application [23]. One cavity of this type is the quarter wave resonator (QWR) cavity [24, 25].

For a QWR cavity, the boundary condition is different. It is more closely related to the coaxial transmission line model. The geometry of a coaxial transmission line can be generalized as shown in Figure 1-2. The scalar potential $\phi(r, \theta)$ between the inner and outer conductor satisfies the following equation.[26]

$$\frac{1}{r} \frac{\partial}{\partial r} \left(r \frac{\partial \phi}{\partial r} \right) + \frac{1}{r^2} \frac{\partial^2 \phi}{\partial \theta^2} = 0, \quad (1-11)$$

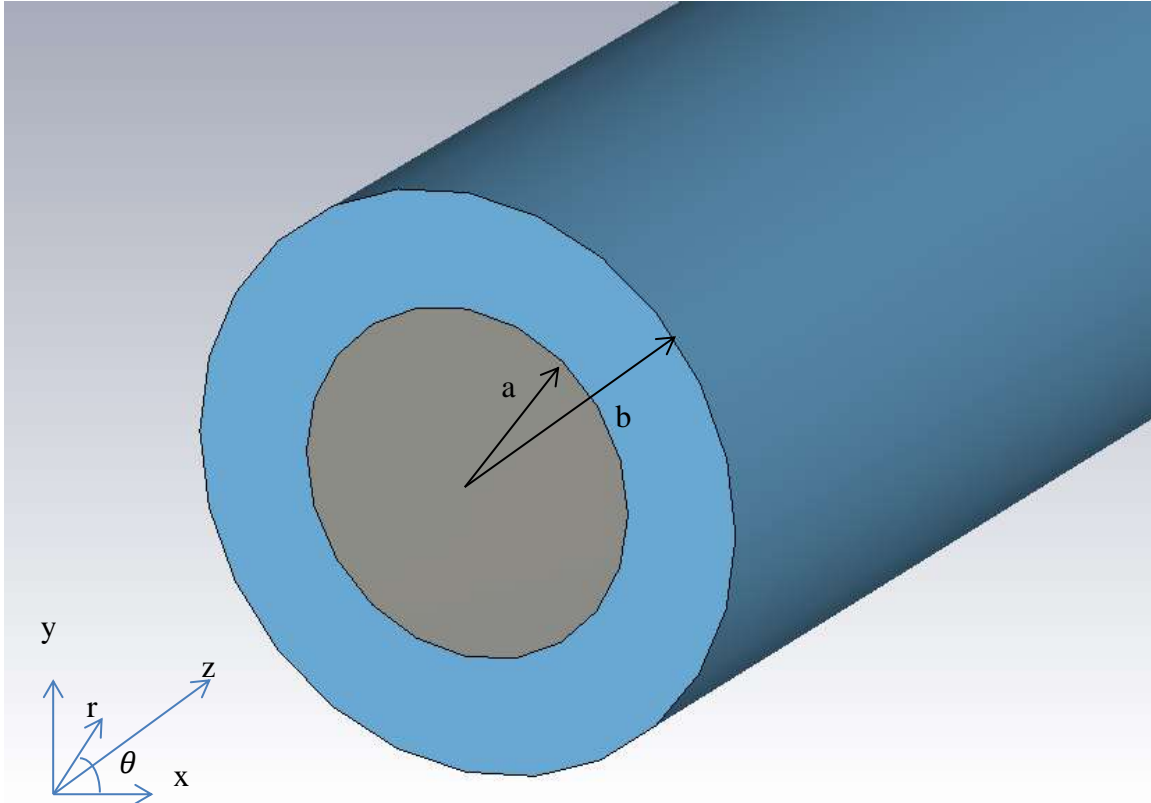


Figure 1-2. The geometry of coaxial transmission line, blue part represent dielectric material.

Now we can separate the variables, $\phi = R(r)T(\theta)$ and substitute back into equation (1-11) and dividing both side by RT we get

$$\frac{r}{R} \frac{\partial}{\partial r} \left(r \frac{dR}{dr} \right) + \frac{1}{T} \frac{d^2 T}{d\theta^2} = 0. \quad (1-12)$$

Two of the terms above must be constants, therefore we set:

$$\begin{aligned}\frac{r}{R} \frac{\partial}{\partial r} \left(r \frac{dR}{dr} \right) &= -k_r^2, \\ \frac{1}{T} \frac{d^2 T}{d\theta^2} &= -k_\theta^2.\end{aligned}\tag{1-13}$$

For the TEM mode, the boundary condition does not change with respect to θ , hence

$k_\theta = 0$, consequently $k_r = 0$. This gives us

$$\frac{\partial}{\partial r} \left(r \frac{dR}{dr} \right) = 0.\tag{1-14}$$

The solution of equation (1-14) is then:

$$R = A \ln r + B, a < r < b.\tag{1-15}$$

This is the scalar potential of the transverse field with constants A and B determined by boundary conditions.

Now assume one end ($z=0$) of the transmission line is shorted, and the other end ($z=d$) is open. Namely, the boundary conditions on $z=0$ and $z=d$ require that $E_t(z=0) = 0$, $H_t(z=d) = 0$ respectively. Hence the z dependence of the E field of TEM mode turns out to be

$$E_t = E_r(r) \sin \left(k \frac{\pi}{d} z \right), k = \frac{1}{2}, \frac{3}{2}, \dots$$

This is the stationary waveform of the field, and the frequency of the lowest order mode is

$$\omega_0 = c \frac{\pi}{2d}.$$

In other words, the wave number of lowest mode is

$$\lambda_0 = 4d,$$

where d is the length of the cavity hence the name of quarter wave resonator.

Besides its compact size, one of the advantages of the QWR cavity is the large separation between the fundamental mode and next higher order TEM mode [27]. From the

boundary conditions, we can easily see that the frequency of next higher order mode is about three times of the fundamental mode where $k = 3/2$ instead of $1/2$. This is important when the cavity is used with high beam currents, where higher order mode (HOM) damping is a more critical issue and larger mode separation between the fundamental mode and next high order mode will make the design of HOM filter easier.

A more realistic QWR is shown Figure 1-3. This is the Superfish [28] plot of our 112 MHz cavity. We can see the length of the cavity is 86.57 cm, which is slightly larger than $1/4$ of the wavelength of 112 MHz TEM mode in an ideal QWR. The reason for this difference is that we need to introduce a gap to provide space for the acceleration of the beam. Various other modifications have been made to the cavity to make it suitable for an electron injector. The shape of the inner conductor is altered to reduce the peak surface magnetic field. The nose cone part, which is the tip of the end of the inner conductor, has been rounded to reduce the peak surface electric field [29]. The cathode stalk, which can be partially seen from the picture, has to be designed such that we can insert the cathode into the cavity without compromising the thermal insulation between the cryo-environment of cavity and cathode system [7].

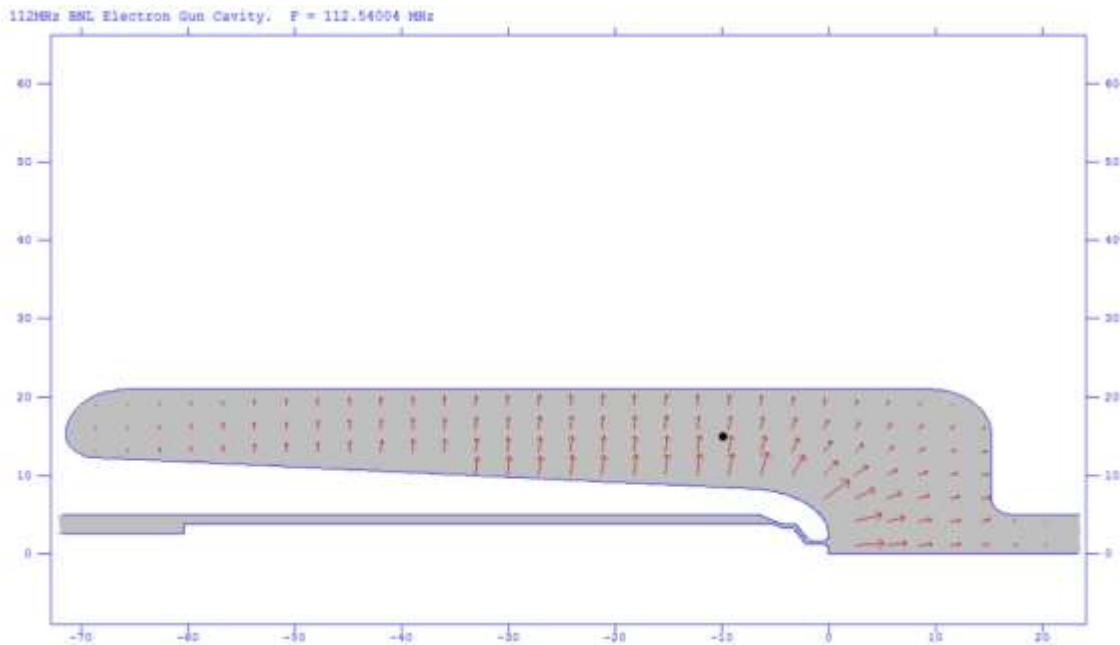


Figure 1-3. 112 MHz cavity E -field distribution (Superfish).

1.1.2 The quality factor of an RF cavity

Another critical figure of merit of an RF cavity is the quality factor. The definition of the quality factor of the cavity is

$$Q_0 = \omega \frac{U}{P_0}, \quad (1-16)$$

where ω is the frequency of the interested mode, U is the energy stored in the cavity, P_0 is the RF power dissipation on cavity wall. The physical meaning of Q_0 is how many RF angular cycles does it take for the cavity to lose the stored energy due to the wall power dissipation.

As we know from general EM theory, the stored energy of EM field in cavity is

$$U = \frac{1}{2} \mu_0 \oint |H|^2 dV. \quad (1-17)$$

For the power dissipated on cavity wall we have

$$P_0 = \frac{1}{2} R_s \oint_S |H|^2 dS, \quad (1-18)$$

where R_s is the surface resistance of the cavity wall material and we are assuming same R_s everywhere here.

Therefore, the quality factor can also be written as

$$Q_0 = \omega \frac{\mu_0 \oint_V |H|^2 dV}{R_s \oint_S |H|^2 dS} = \frac{G}{R_s}, \quad (1-19)$$

where

$$G = \frac{\omega \mu_0 \oint_V |H|^2 dV}{\oint_S |H|^2 dS}, \quad (1-20)$$

is the so-called geometry factor of the cavity. For a given mode, the geometry factor depends only on the shape of the cavity. The typical geometry factor of a pillbox cavity optimized to maximum acceleration is $G = 257 \Omega$ [30]. The geometry factor of the 112

MHz QWR cavity is 38Ω . Clearly this is lower than the geometry factor of the pillbox cavity, this is a price we pay for building a compact, low-frequency cavity. However, the simulated Q_0 of the 112 MHz cavity when it is superconducting is 2.4×10^9 . This value is comfortably high so that we do not have to worry about the intrinsically low value of its geometry factor.

1.1.3 The Shunt Impedance and R/Q

The shunt impedance is another important figure of merit that is used to characterize the efficiency of the cavity, which is defined as

$$R_a = \frac{V_C^2}{P_0},$$

where V_C is the cavity voltage (for the acceleration of a beam particle, as discussed below) and P_0 is the power dissipation on the cavity wall.

This parameter tells us what cavity voltage we can obtain for unit power loss on walls. From equation (1-16) we can see that

$$\frac{R_a}{Q_0} = \frac{V_C^2}{\omega U},$$

which is independent of the surface resistance R_s . This figure of merit is also independent of the cavity size and is very important when estimating the mode excitation by charged particles in the RF structure. The R/Q of our 112 MHz QWR cavity is 122Ω . This is smaller than the R/Q of a typical pillbox cavity, which is about 200, however this is an acceptable trade-off for the QWR cavity to get a low operating frequency.

1.1.4 The Transit Time Factor and the Acceleration Voltage

When a particle passes through the RF field in the cavity, the field seen by the particle will change with time during the process. This effect will cause phase slippage and changing in energy gain. More specifically, the field strength seen by the particle can be written as

$$E = E_0(z)e^{-i(\omega t(z)+\phi_0)}, \quad (1-21)$$

where $E_0(z)$ is the amplitude of electric field which is a function of z coordinate, ω is the frequency of the field, $t(z)$ is the time electron reaches position z , ϕ_0 is the initial phase of the field. For this purpose, we assume that the particle is moving along the symmetry axis of the cavity.

If we are dealing with relativistic $\beta \sim 1$ particles, for example the electrons with energy larger than 10 MV, we can approximate the speed of electron to be the speed of light. Along with the assumption of a TM_{010} mode, we can significantly simplify the expression of field,

$$E = E_0 e^{-i\left(\frac{\omega z}{c} + \phi_0\right)}. \quad (1-22)$$

And the energy gain of particle through the cavity is

$$\begin{aligned} W &= q \left| \int_0^g E_0 e^{-i\left(\frac{\omega z}{c} + \phi_0\right)} dz \right| \\ &= g \frac{qE_0 \sin\left(\frac{\omega g}{2c}\right)}{\frac{\omega g}{2c}}, \end{aligned} \quad (1-23)$$

where q is the charge of the particle and g is the acceleration gap of the cavity.

We use this expression to define the transit time factor for a pillbox cavity excited in the TM_{010} mode:

$$T = \frac{W}{qE_0 g} = \frac{\sin\left(\frac{\omega g}{2c}\right)}{\frac{\omega g}{2c}}. \quad (1-24)$$

Since the electric field distribution of the quarter wave resonator on axis in the accelerating gap is identical to that of the pillbox cavity, this definition of the transit time factor holds. For the injector case, since the velocity of the particle starts from zero, we cannot assume a constant velocity anymore [31]. In this case, it is convenient to use a numerical code to integrate the energy gained W by tracking the particle through the meshed cavity gap then calculate the acceleration voltage,

$$V_{\text{acc}} = \frac{W}{q}. \quad (1-25)$$

For our 112 MHz cavity, the acceleration voltage is 2 MV across the $g = 25$ cm acceleration gap. And this gives us the acceleration electric field.

$$E_{\text{acc}} = \frac{V_{\text{acc}}}{g} = 8 \text{ MV/m}. \quad (1-26)$$

The transit time factor is equal to 0.97.

1.1.5 The Peak Surface Field ratios $\frac{B_{\text{max}}}{E_{\text{acc}}}$ and $\frac{E_{\text{max}}}{E_{\text{acc}}}$

When designing a superconducting cavity, one issue that deserves careful consideration is avoiding a quench of the cavity due to exceeding critical magnetic field of the niobium (assuming our cavity is made of niobium), or excessive electric fields that can lead to field emission of electrons from the walls of the cavity. Since we use the electric field to accelerate the particles, we would like to get the electric field as high as possible for a given maximum value of magnetic field in the cavity. Namely, we'd like to gain as much as possible before the magnetic field reaches the limit where cavity will quench beyond that point. $\frac{B_{\text{max}}}{E_{\text{acc}}}$ is a way of quantifying this figure of merit. Smaller number means better geometry of the cavity in terms of getting more electric field given certain amount of magnetic field budget. Similarly, $\frac{E_{\text{max}}}{E_{\text{acc}}}$ is another figure of merit that allows us to minimize the field emission for a given amount of accelerating field.

The design parameters of the 112 MHz QWR cavity are summed up and shown in Table 1-1.

Table 1-1. Design parameters of 112 MHz cavity.

Frequency	112 MHz
V_{acc}	2 MV

Q_0	2.4×10^9
Geometry factor	38Ω
R/Q	122Ω
Cathode surface E field	26 MV/m
$\frac{B_{\max}}{E_{\text{acc}}}$	$1.91 \text{ mT}/\left(\frac{\text{MV}}{\text{m}}\right)$
$\frac{E_{\max}}{E_{\text{acc}}}$	4.70

1.2 Multipacting Study

Another phenomenon worth discussion in a separate section is multipacting [32]. This phenomenon, which can be troublesome in normal-conducting RF structures, is of great importance to the SRF structures which can tolerate much less power dissipation in the cavity. Let's first have a look at what is it.

1.2.1 Multipacting

The multipacting is a type of electron emission and multiplication in vacuum in an RF structure.

Consider the following process: Initially, there is a free electron created either by cosmic radiation ionizing the residual gas inside the chamber or field emission from the surface. Then this electron travels under the influence of Lorentz force. Eventually, the electron will hit the wall with some kinetic energy, which depends on the field strength and frequency, the initial phase and starting location. We neglect absorption by the residual gas since the cavity is well evacuated. If this electron hits the wall with a kinetic energy in some particular range (which depends on the material of the wall), it is possible for the initial electron to knock more than one electron out of the surface. In this case we have

amplification, or in other words the Secondary Electron Yield (SEY) is larger than one. However, only having $SEY > 1$ is not enough to have multipacting. The geometry and electromagnetic mode configuration of the cavity are also important. If the generated secondary electrons come out of the surface in right RF phase, it will gain energy, travel through the cavity and may strike the wall with the favorable energy for secondary emission. Thus, it will also generate more than one secondary electron. Imagine this process continues for tens or even thousands of times, the total number of electrons bouncing back and forth between the walls of the RF structure may grow exponentially. This electron discharge phenomenon is called multipacting.

We can easily see the severe consequence of the multipacting if we evaluate the following expression, assuming the SEYs are all the same for every impact and equal to 1.5,

$$N = 1.5^n. \quad (1-27)$$

If the electrons can survive 50 impacts, then the number of secondary electrons will reach 6.37×10^8 which is more than 0.1 nC.

If we make the following assumptions:

We have a two-point first order multipacting which means the resonance electrons travel between two different wall segments and each way takes one RF period of 112 MHz field,

The impact energy is 1 keV.

Then we can calculate the current and power of the multipacting at this moment:

$$I = \frac{eN}{T} = \frac{1.6 \times 10^{-19} \times 6.37 \times 10^8}{\frac{1}{112 \times 10^6}} = 11.4 \text{ mA}, \quad (1-28)$$

$$P = I \times 1 \text{ keV} = 11.4 \text{ W}.$$

This is a significant power drain from RF field. Remember the power loss on SRF cavity wall is typically the same level (12 W for 112 MHz QWR cavity under 2 MV gap voltage). Therefore, this multipactor could significantly change the coupling factor of the injector and prevent the RF power from coupling into the cavity hence cap the RF field

strength to the level where multipacting happens if we have no means of changing the coupling or condition the multipactor out.

Therefore, we need to perform a numerical simulation on the RF structures we designed and try to foresee and possibly eliminate potentially dangerous multipacting.

1.2.2 Examples of Multipacting

The multipactors are typically categorized in two different ways. One is ordered regarding the number of RF cycles electrons travel before each impact. If the electron impact with the wall after each RF cycle then we call it a first order multipactor. If it takes two RF cycles to reach next impact point, then we call it second order multipactor, so on and so forth. The other way of categorizing the multipactor is based on the number of points between which the resonant particle is bouncing [33]. For example, if the resonant electron leaves the wall and comes back at the same point or a point that is very close to the initial one, we call it a one point multipactor, if it travels back and forth between two points then we call it a two-point multipactor.

Figure 1-4 shows a typical two-point multipactor at the high magnetic field region of 112 MHz QWR cavity. The green line illustrates the trajectory of the resonant electron. One thing should be pointed out: this is only showing a possible resonant electron trajectory. In order to generate real multipacting the impact energy has to satisfy $\delta(E_k) > 1$, namely the net gain has to be larger than one for the exponential growth of total number of electrons to kick in.

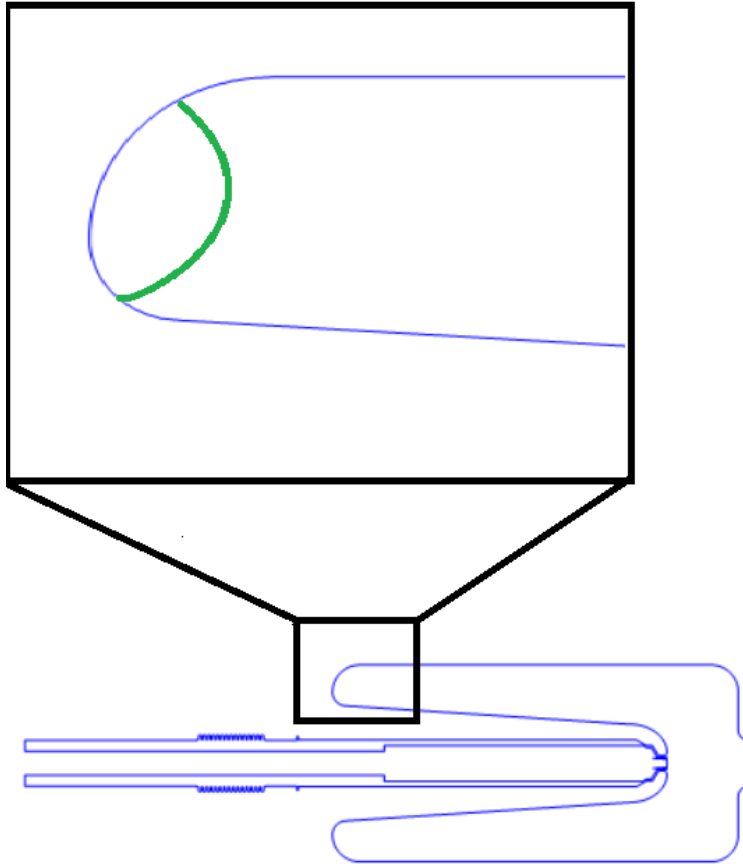


Figure 1-4. Typical 2-point Multipactor found in 112 MHz cavity by code Fishpact.

1.2.3 Analytical treatment of multipacting

There are several analytical treatments developed over the years in the community to evaluate the multipacting risk of RF structures [34, 35, 36].

The simplest model of the multipacting is the parallel-plates scenario where two parallel electrodes provide uniform and harmonically oscillating field. The process of multipacting is shown in Figure 1-5.

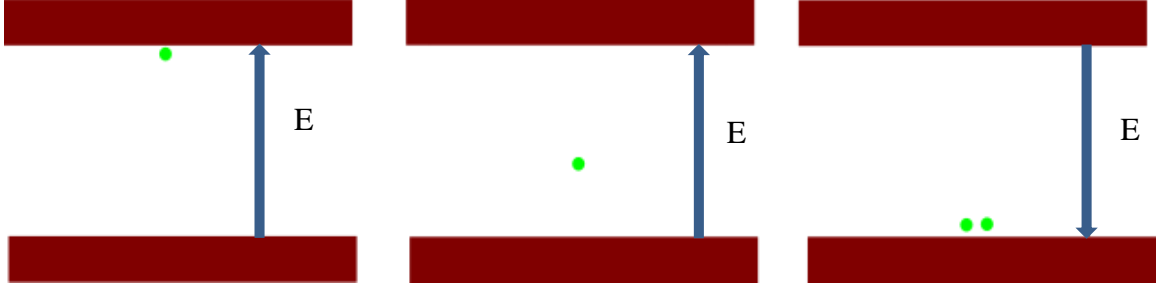


Figure 1-5. MP between parallel plates.

The equation of motion of the electron can be written as

$$\ddot{x} = \frac{qE}{m}, \quad (1-29)$$

where x is the distance electron travels starting from one plate, E is the electric field, m is the mass of the electron and q is the charge of the electron.

If we assume the form of electric field as $E = E_0 \sin(\omega t + \phi_0)$ with E_0 as the amplitude, ω as the frequency and ϕ_0 as initial phase, we can solve this equation as

$$\begin{aligned} \dot{x} &= -\frac{q}{m\omega} E_0 \cos(\omega t + \phi_0) + C_1, \\ x &= -\frac{q}{m\omega^2} \sin(\omega t + \phi_0) + C_1 t + C_2, \end{aligned} \quad (1-30)$$

where C_1 and C_2 can be determined by initial condition.

For multipacting to happen, we need the electron to reach the opposite wall after an odd number of half periods of the field oscillation. Namely, if the electron leaves the upper surface at phase ϕ_0 , it has to reach the lower plate, assume gap distance is d , at phase $\phi = N\pi + \phi_0, N = 1, 3, 5, \dots$

Thus, we have the resonance condition on the gap size d as

$$d = -\frac{qE_0}{m\omega^2} \sin(\omega t + \phi_0) + C_1 t + C_2. \quad (1-31)$$

Assuming the initial condition to be $x_0 = 0, \dot{x}_0 = v_0$, we can further determine the integration constants as $C_1 = v_0 + \frac{qE_0}{m\omega} \cos(\phi_0), C_2 = \frac{qE_0}{m\omega^2} \sin(\phi_0)$. Plugging these into equation (1-31) we get

$$d = -\frac{qE_0}{m\omega^2} [\sin(\omega t + \phi_0) - \cos(\phi_0)t - \sin(\phi_0)] + v_0 t. \quad (1-32)$$

And consequently the condition on the amplitude of the electric field is

$$E_0 = \frac{m\omega(\omega d - v_0 N\pi)}{e(N\pi \cos(\phi_0) + 2\sin(\phi_0))}. \quad (1-33)$$

Another very common situation is the coaxial structure scenario. Due to the field distribution between the inner and outer conductor, the transit time from the inner to the outer conductor is shorter than the reversed process. Moreover, because of the radial dependence of the field distribution, several approximations need to be taken [35, 36, 37]. Two very useful results from these references are:

- For the two-sided multipactor to occur, the ratio between radius of outer and inner conductor has to be smaller than $\sqrt{3}$ [36].
- In a coaxial coupler, the forward power under which multipacting occurs can be written as

$$P_n = \frac{A\omega^4(r_2 - r_1)^4 m^2}{(2n - 1)^2 \pi \eta e^2} \ln \left(\frac{r_2}{r_1} \right)^{-1}, \quad (1-34)$$

where A is the correction factor, $A=1$ for traveling wave and $A=1/4$ for full reflection standing wave, ω is the frequency of the field, $\eta = 377\Omega$, r_2 and r_1 are the radii of outer and inner conductor respectively, m is the mass of electron and e is the charge of electron. [35]

The results above adopted either a slow variation approximation or a constant field approximation. The analytical formulas are very useful to make a quick estimation when the geometric model of the RF structure is relatively simple. In order to study a complex shape, for example, the coupler, people usually seek the help of numerical simulations, which will be discussed in following sections.

1.2.4 Method of simulation

First computer code for multipacting simulation was written decades ago [38]. People are still trying to develop better code and algorithm to do the job more accurately and efficiently.

The typical approach to multipacting simulation can be decomposed into following steps [39]:

- Build a model for the RF structure of interest.
- Run an EM simulator to get the distribution of the EM field we want to use.
- Run a tracking algorithm to track the electrons under the RF field. If the electron hits a wall segment, record the impact energy. If the RF phase is in favor of emission, then re-initialize the electron from this wall segment and keep tracking it. This can be done to millions of electrons for a preset number of RF cycles.
- After the tracking is done, calculate the yield of each impact for all resonant electrons which survived at the end of tracking. For each resonant electron calculate the so-called enhanced counter function C which is defined as following

$$C = \prod_{i=1}^N \delta_i, \quad (1-35)$$

where i indicates the impact number, N is the total number of impacts this electron survived, δ_i is the yield of i th impact. δ can be calculated from the SEY curve of wall material which usually is measured beforehand or calculated from analytical model [40].

1.2.5 GPU code for multipacting simulation and results

There are several 2D codes that can handle structures with cylindrical symmetry such as Multipac [41] and Fishpact [42]. To deal with 3D structures, we have Track3P solver in the ACE3P [43] package and Particle Studio in the CST suite [44]. For 2D codes, the limitation is obvious, especially when we are dealing with a power coupler problem where the structures are usually lacking azimuthal symmetry. The Track3P code is extremely powerful regarding the range of problems it can handle, but it also requires a cluster such as NERSC [45] to fully harness this power. Therefore, we developed a GPU-

based 3D tracking code to increase the turnover of the multipacting simulation in SRF structures. This code can run on either PC or workstation as long as a GPU that supports NVidia CUDA Computing Capability 1.3 and above is available.

Brief Introduction to the GPU

Compared to a CPU, the GPU is a relatively new face in general purpose computing. The original purpose of a dedicated GPU is to process vectors more efficiently [46, 47, 48]. The monitor screen rendering process is essentially a matrix updating job. Take one simplest example, if there is a cube displayed on the screen and we'd like to perform a drag and rotate operation on the object. What the rendering engine can do is to record the mouse cursor location before and after the drag motion, then calculate the new location of the key points on the cube then update the perspective display of the object. Getting the new location of the key points is the step that involves the matrix multiplication since the rotation can be seen as a linear transformation. The GPU is designed to do this type of calculation quickly. Imagine we are facing not merely two key points of a cube but millions of them, for example, we are dealing with some complicated model with tens of thousands polygons in a modern video game or millions of electrons in a multipacting simulation, the advantage of GPU then becomes clear. The reason that GPU can deal with this type of problem very efficiently is that the GPU has more computing units. Each unit is relatively simple, as compared to the CPU. However, a CPU spends significantly larger chip area on logic and control unit, see Figure 1-6. The GPU works under the so-called Single Instruction Multi Data scheme that is ideal for dealing with simple tasks in bulk volume.

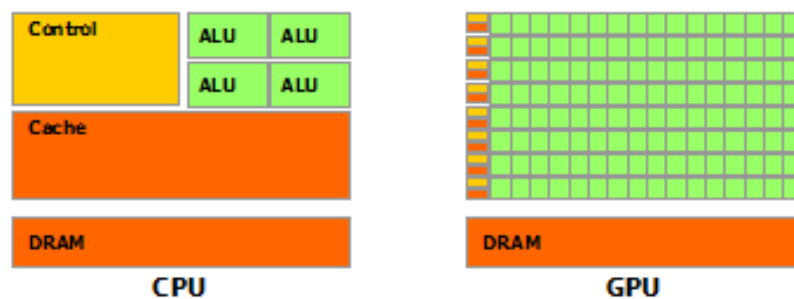


Figure 1-6. GPU devotes more transistors to data processing (ALU)[49].

STRUCTURE OF THE CODE

The idea of our GPU based multipacting code is to take the advantage of high concurrency of the GPU to track millions of particles simultaneously to simulate the multipacting phenomenon. There are three primary parts in the code.

- Main (Master) Function

The main function is a host function that runs on the CPU and controls the workflow of the program. All the kernels running on GPU are launched from the host code. First, the input parameters are read into the main function from an input file. Then the code reads in the geometry model of the structure and the EM field distribution from Omega3P Eigensolver. The mesh model will be pre-processed before it is sent to the GPU so that the particles can be located more easily when it is going through the tracking process. Then the main function calls the sequence of the core kernels in the display call back function of the OpenGL so that the tracking process is synchronized with the rendering process. The core tracking kernels will be discussed below.

- Momentum Update

Initial locations, momentums and relative RF phases of the particles are generated by a kernel called `init_par` on GPU. Then the field strength at the location of the particle is calculated by using first-order shape function of the tetrahedral element and the field information on the vertexes of the element in which the particle is located. After the field information is ready, the momentum-updating kernel takes the pointer to the segment of global memory that stores the information and starts calculating the new momenta of the particles. The momentum-update task is done by a fourth order Runge-Kutta method [50]. After the momenta are updated, the new location of the particle is also updated as if there is no collision. We call this a virtual movement of the particle. The further steps will be conducted by the particle locating kernel, which will be discussed later.

Since momentum updating does not involve memory copying between the GPU and the CPU, we can save a considerable amount of time. Each momentum-

updating kernel requires 90 registers, which still needs some optimization. However, even with this amount of register requirement a low tier GeForce GTX 860M GPU can run about 50 thousands of the kernels simultaneously and finish one iteration in about 30 ms for 2 million particles.

- Particle Locating

The code spends a major portion of time on determining the final location of the particles after each virtual movement. The data structure of the mesh model is organized so that each mesh element also stores the IDs of the four neighbor elements as well as the internal ID of the surfaces they shared. Every time after the particle is virtually moved by the momentum updating kernel, we follow the procedure of following pseudocode [51, 52]:

Calculate the Barycentric coordinates (B-coords) [53] of the particle in the old element.

If the particle is still in the old tetrahedral mesh (all B-coords > 0):

 Make a real movement on the particle;

 Update the momentum of the particle;

 Return;

Else:

Calculate the parametric coordinates (a, b) of intersect of the virtual trajectory of the particle with all four walls of the tetrahedral element it was originally in.

There will be one and only one pair of coordinates that falls in the range $0 < a < 1$, $0 < b < 1$, $a + b < 1$ and the side corresponding to that pair is the side that the virtual trajectory went through.

 If the particle hits a wall for the first time:

 Record the ID of the wall hit by the particle;

```
    Generate the new momentum of the particle as if it is a new
    particle;

    Flag the particle as a particle that just hit a wall;

    Return;

Else if the particle hits the wall in previous time step:

    Flag the particle as dead;

    Return;

Else if the particle hit a shared wall:

    Update the ID of tetrahedral mesh the particle is located and go
    back to the top of the code.
```

The code keeps a record of how many steps the kernel took to find the particle eventually and adjust the interval of time step of each particle accordingly. If the kernel took too long to locate the particle, the time step would be halved in next iteration.

After every particle is either located or registered dead, the master clock advance by one time step and the EM field is updated.

After every certain amount of time, two RF cycles is set as a default, the master function calls the memory-copy function to copy the results back from GPU to CPU and perform a sort method on the flags to get rid of the dead particles so that the following simulation can focus on the active particles only.

The particle-locating kernel requires significantly more registers (180) and has much more branching than the momentum update kernel. Both are undesirable for a GPU code. However, the maximum achievable GFLOPs of this kernel on a Tesla K40 card is still around 150 which is about three times than an Intel i7 quad-core CPU can provide. Although there is still ample of space for improvement on the algorithm of this kernel, we already can see the power of a GPU accelerated code. Figure 1-7 shows the performance boost of the GPU code compares to the CPU version.

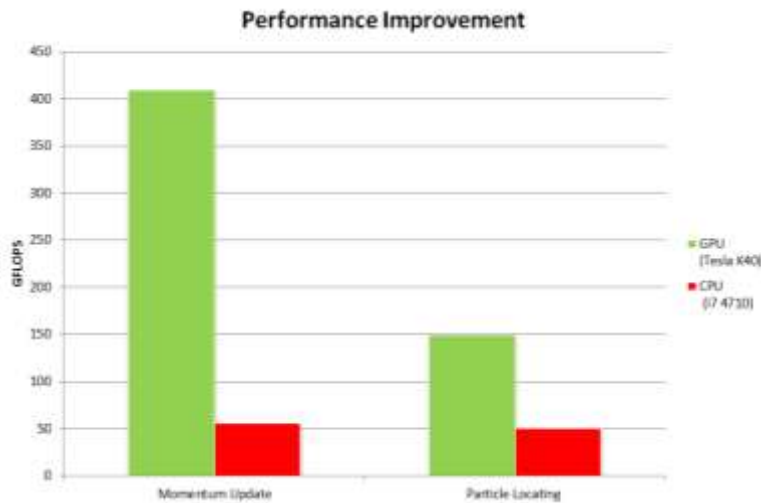


Figure 1-7. The performance boost of GPU code.

Simulation results

The location of multipactors is shown in Figure 1-8.

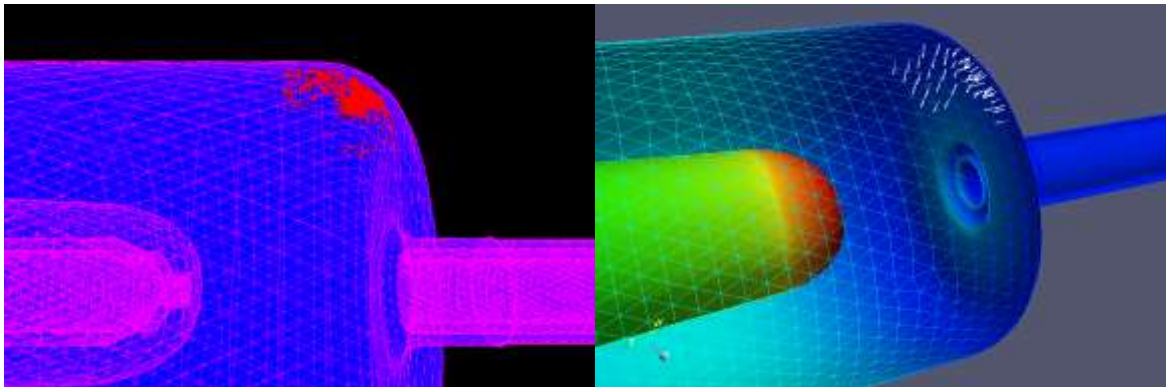


Figure 1-8. Location of MP in the 112 MHz cavity given by (Left) GPU code shown as red dots and (right) Track3P shown as white dots.

The multipacting occurs at a gun voltage equal to 40 kV. In results from both codes, the resonant particles exhibit two-point multipacting in the corner between exit vertical wall and the outer conductor of QWR cavity. The highest enhanced counter function is 1×10^7 . This multipacting barrier was observed in the first commissioning after the cavity was fabricated in Niowave Inc. and quickly conditioned [54].

1.3 Tuning: Simulation and Measurements

Active Mechanical tuning

The 112 MHz cavity is designed to be compatible with the RHIC system. In order to match the electron beam to RHIC ion beam, it is essential that the cavity can be tuned to cover at least 78 kHz [55] around the 112 MHz central frequency. A mechanical tuner has been installed inside the cryomodule. The mechanical deformation was calculated by the simulation code Ansys and the frequencies of the original and deformed cavity were calculated by Superfish and CST microwave studio. The simulation shows that the frequency change rate provided by this tuner is about 14 kHz/mm. This compares well with the experimental measurement during the first commissioning at Niowave Inc. which is shown in Figure 1-9.

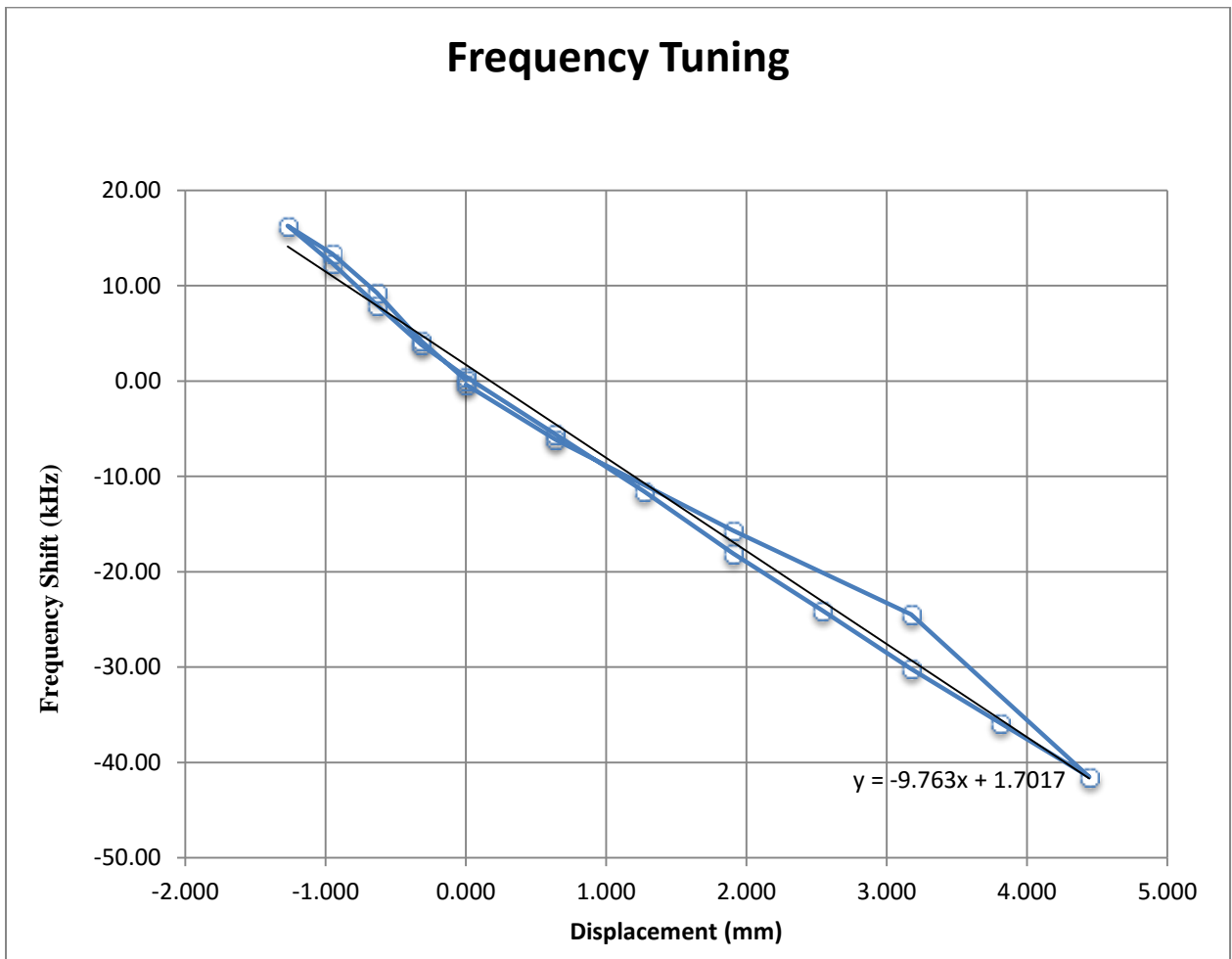


Figure 1-9. Mechanical Tuning of 112 MHz cavity, the straight line shows linear fitting.

Detuning due to Helium pressure change

Another important figure of merit is the sensitivity of cavity frequency to the helium pressure inside the helium vessel. Due to its high loaded Q (Q_L), the SRF cavity is very sensitive to frequency shift. For example, assume the loaded Q is 1×10^8 and the central frequency is 112 MHz, then the FWHM of the resonance peak is in the order of 1 Hz. Therefore the sensitivity of the cavity frequency to the ambient condition, in this case the helium pressure, is of great importance and requires special consideration when designing a cavity.

The cavity model is first generated in Ansys, and the pressure boundary condition is applied to the outer surface of the shell structure. Then the deformation is calculated by the Multiphysics solver to generate the deformed cavity. Then we export the deformed cavity to Superfish to calculate the shifted frequency. The simulated frequency sensitivity due to pressure change is 14 ± 4 Hz/mbar. By pressurizing the helium vessel one can measure the frequency change as a function of the helium pressure. The experimental result of the pressure sensitivity is shown in Figure 1-10 [56].

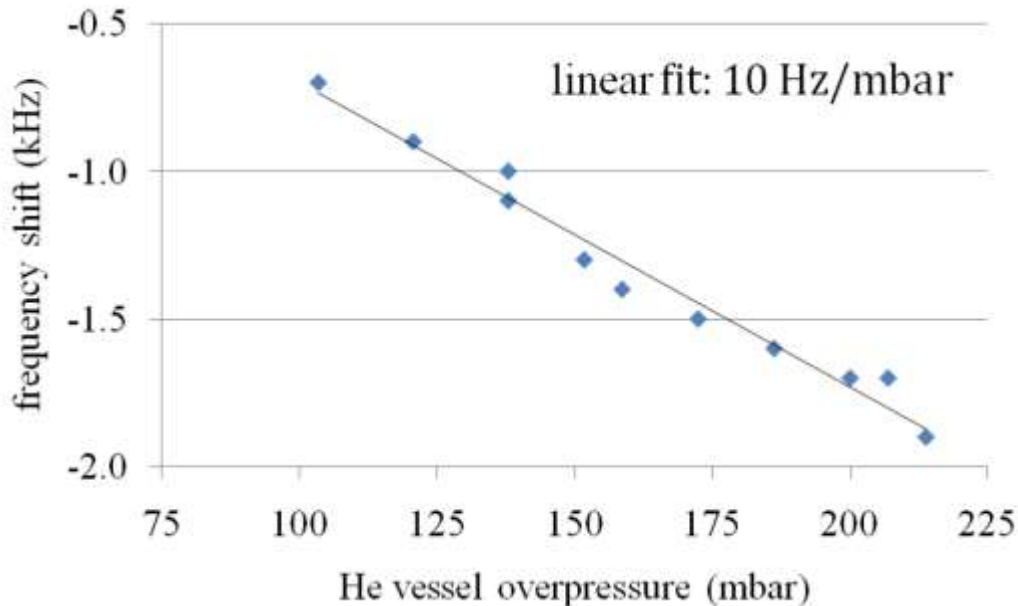


Figure 1-10. Measured cavity frequency shift vs. helium vessel overpressure (measured as mbar above atmospheric pressure).

Lorentz Detuning Simulation and Measurement

Another important detuning to the cavity is the so-called Lorentz detuning which is caused by the RF field stored inside the cavity [57].

The force exerted by the electric field on the cavity wall can be derived in the following way.

First, we assume the cavity wall to be the perfect conductor, which is a good approximation for SRF cavities. The field is normal to the wall and the field strength is constant across a small area. In this case the relation between the field E and the charge density σ is

$$E = \frac{\sigma}{\epsilon_0}. \quad (1-36)$$

The pressure of Lorentz force generated by electric field (self-field excluded) is

$$P_E = \frac{\epsilon_0 E^2}{2}. \quad (1-37)$$

Similarly, we can derive the pressure from the magnetic field as

$$P_H = \frac{\mu_0 H^2}{2}. \quad (1-38)$$

The direction of the electric force is pointing out of the wall surface, and the effect of the magnetic force is the opposite.

Therefore, the total pressure of Lorentz force is

$$P_L = \frac{\mu_0 H^2}{2} - \frac{\epsilon_0 E^2}{2}, \quad (1-39)$$

where H and E are the effective field strength of magnetic and electric field, respectively.

One thing worth pointing out is the Lorentz detuning to cavity frequency is always negative. One way to understand this is by looking at a typical pillbox cavity. The electric field always tends to pull the iris together hence reduce the vacuum volume, in other words, increase the capacitance and reduce the frequency of the resonator. The magnetic

field will push the wall outwards and increase the inductance and again reduce the resonance frequency. This gives us a qualitative feeling of the Lorentz detuning.

To calculate the frequency shift of the cavity due to its shape distortion (Figure 1-11), the fundamental formula we need to use is the so-called Slater's perturbation formula which can be derived in the following way [26].

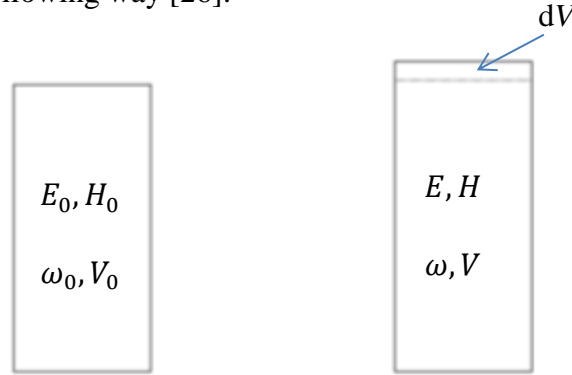


Figure 1-11. Original cavity volume (left) and deformed cavity (right).

From the Maxwell's equations, we get the curls of the electric and magnetic field as following: (All the symbols for field are vectors if not specified.)

$$\begin{aligned}
 \nabla \times E_0 &= -j\omega_0\mu H_0, \\
 \nabla \times H_0 &= j\omega_0\epsilon E_0, \\
 \nabla \times E &= -j\omega\mu H, \\
 \nabla \times H &= j\omega\epsilon E.
 \end{aligned}
 \tag{1-40}$$

Here we use j as the imaginary unit, ω is the frequency of the EM field. Quantities with subscript 0 means they are the original ones. Take the conjugate of first one and multiply it with H , and multiply the last one with E_0^* we get

$$\begin{aligned}
 H \cdot \nabla \times E_0^* &= j\omega_0\mu H \cdot H_0^*, \\
 E_0^* \cdot \nabla \times H &= j\omega\epsilon E_0^* \cdot E.
 \end{aligned}
 \tag{1-41}$$

Use the first to subtract the second one in (1-41)

$$H \cdot \nabla \times E_0^* - E_0^* \cdot \nabla \times H = j\omega_0\mu H \cdot H_0^* - j\omega\epsilon E_0^* \cdot E.
 \tag{1-42}$$

Notice the LHS is the identity of $\nabla \cdot (E_0^* \times H)$ we get

$$\nabla \cdot (E_0^* \times H) = j\omega_0 \mu H \cdot H_0^* - j\omega \epsilon E_0^* \cdot E. \quad (1-43)$$

Similarly, we can get

$$\nabla \cdot (E \times H_0^*) = -j\omega \mu H \cdot H_0^* + j\omega_0 \epsilon E_0^* \cdot E. \quad (1-44)$$

Add the equation (1-43) with (1-44) and integrate over the new volume of the cavity we can get

$$\begin{aligned} \oint_V (\nabla \cdot (E_0^* \times H) + \nabla \cdot (E \times H_0^*)) dV &= \oint_S ((E_0^* \times H) + (E \times H_0^*)) \cdot dS \\ &= \oint_S (E_0^* \times H) \cdot dS = j(\omega - \omega_0) \oint_V (\mu H \cdot H_0^* + \epsilon E \cdot E_0^*) dV. \end{aligned} \quad (1-45)$$

The second step can be obtained by noticing $E \times ds = 0$, namely using the perfect conductor condition.

Since the perturbed surface $S = S_0 - \Delta S$, we can rewrite the LHS of (1-45) as

$$\begin{aligned} \oint_S (E_0^* \times H) \cdot dS &= \oint_{S_0} (E_0^* \times H) \cdot dS - \oint_{\Delta S} (E_0^* \times H) \cdot dS \\ &= - \oint_{\Delta S} (E_0^* \times H) \cdot dS. \end{aligned} \quad (1-46)$$

Similar to the argument above, by using $E_0 \times n = 0$ on S_0 we got rid of the first term after first equal sign.

Plug equation (1-46) into to (1-45) we can get the expression of frequency shift as

$$\omega - \omega_0 = - \frac{j \oint_{\Delta S} (E_0^* \times H) \cdot dS}{\oint_V (\mu H \cdot H_0^* + \epsilon E \cdot E_0^*) dV}. \quad (1-47)$$

If we assume ΔV and ΔS to be small and take approximation $E \approx E_0$, $H \approx H_0$, we can find

$$\oint_{\Delta S} (E_0^* \times H) \cdot dS \approx \oint_{\Delta S} (E_0^* \times H_0) \cdot dS. \quad (1-48)$$

Equation (1-48) is the well known integral of Poynting's vector across an enclosed surface. When there are no losses, the Poynting vector integral across the enclosed surface is simply

$$\oint_{\Delta S} (E_0^* \times H_0) \cdot dS = j\omega_0 \oint_{\Delta V} (\mu H_0^2 - \epsilon E_0^2) dV. \quad (1-49)$$

Plug back to equation (1-47) we will get

$$\frac{\omega - \omega_0}{\omega_0} = \frac{\oint_{\Delta V} (\mu H_0^2 - \epsilon E_0^2) dV}{\oint_V (\mu H_0^2 + \epsilon E_0^2) dV}. \quad (1-50)$$

Again, the volume within which magnetic field dominates will expand as we discussed before, this gives us a negative ΔV if we follow the definition we used here and for the strong electric field part we get positive ΔV . Hence, the overall effect from both parts is reducing the frequency of the cavity.

In practice, we use the numerical code to simulate the sensitivity of cavity to Lorentz detuning effect in a similar manner to what we applied above in carrying out the pressure sensitivity analysis.

The steps described below apply to CST 2014 and 2015.

First, we build a real shell model of the cavity and the vacuum volume of the cavity.

Then we calculate the field distribution of the interested Eigen mode of the cavity. In this step, we use only the vacuum volume of the cavity and disable the shell part.

Next, we use the internally built Lorentz force processor in the High Frequency (HF) solver of CST package to generate the Lorentz force distribution from the field distribution.

Then we create a new project in the mechanical simulation solver, namely the Multiphysics solver. This new project contains the same geometries as the HF one but with shell activated and vacuum disabled. The deformation of the shell is then calculated with the Lorentz force field imported from the HF solver.

Finally, we go back to the first project and import the deformation from the Multiphysics solver and do the sensitivity analysis to get the new frequency.

Figure 1-12 shows the deformation of the cavity when gun voltage is 2 MV.

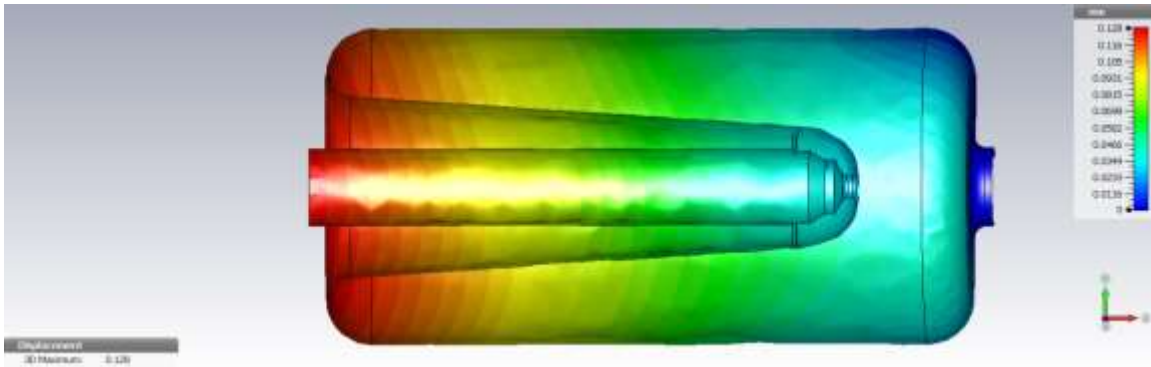


Figure 1-12. Deformation of the cavity when gun voltage equals to 2 MV.

The frequency shift due to this deformation is -746 ± 6 Hz. Hence the Lorentz detuning sensitivity is 186 ± 1.5 Hz/MV². This amount of detune can be easily tuned back by active tuner.

1.4 Summary

In this chapter, we discussed the design of the 112 MHz cavity. We listed and derived several important figures of merit in cavity design such as center frequency, the quality factor, the geometry factor, the R/Q , the maximum field ratios B_{\max}/E_{acc} and E_{\max}/E_{acc} , and the transit time factor. The designed parameters are presented in this chapter. We chose the QWR cavity so that the cavity can be made compact for 112 MHz frequency. Although we sacrificed the shunt impedance R/Q and the maximum field ratios by choosing this shape, we gained the advantage of a realistic cavity size, a longer acceptable beam bunch length and a larger bunch charge. The multipacting phenomenon was discussed in detail, and a GPU accelerated code was written by the author to increase the productivity of multipacting simulation. Simulation results from both GPU code and Track3P show that the multipacting in the cavity is not problematic. The sensitivity of cavity to the helium pressure and Lorentz detuning was also discussed in the second half of the chapter. The simulation results and experimental measurements are consistent with each other.

2 Fundamental Power Coupler (FPC) / Fine Tuner Design and Fabrication

Due to the geometric limitation in the cavity which was built for a different purpose, we decided to use the coaxial structure fundamental power coupler (FPC). The main purpose of the FPC is, of course, providing the RF power to the cavity and beam. However by adjusting the position of the FPC, we can also adjust the frequency of the cavity and thus provide a fine tuning mechanism for the injector. The deviation of the external coupling of the FPC, due to the fine tuning action from its optimal value is small and can be easily compensated by adjusting the RF drive power. When we were designing the FPC, the first thing we had to consider was the capability of the FPC. Namely, whether we can provide enough power to the beam, or in other words can we get enough coupling. Another issue is whether or not we need an active cooling for the FPC. The coaxial structure provides strong coupling and potentially generate a significant amount of RF loss on its surface, and this heating has to be closely studied. The third issue of the FPC is the multipacting study, which will be discussed later in this chapter.

2.1 RF Design of the FPC

The fundamental power coupler is a coaxial type coupler similar to the one used in the Naval Postgraduate School (NPS) gun [58]. The coupler is attached to beam exit port of the SRF gun. Its hollow center conductor, or coupling tube, allows the beam to go through. Adjusting the penetration of the coupling tube towards the acceleration gap allows us to tune the cavity resonant frequency as well as keep the coupling strength in a good range. Figure 2-1 illustrates the FPC attached to the SRF gun port. The main parameters of the fundamental power coupler are listed in Table 2-1.

Table 2-1. Parameters of the fundamental power coupler

Frequency tuning range by FPC	4.5 kHz
Travel range	40 mm
Q_{ext} , min.	$1.25 \cdot 10^7$
Max. RF power loss on the inner conductor	899 W
Max. RF power loss on the outer conductor	555 W

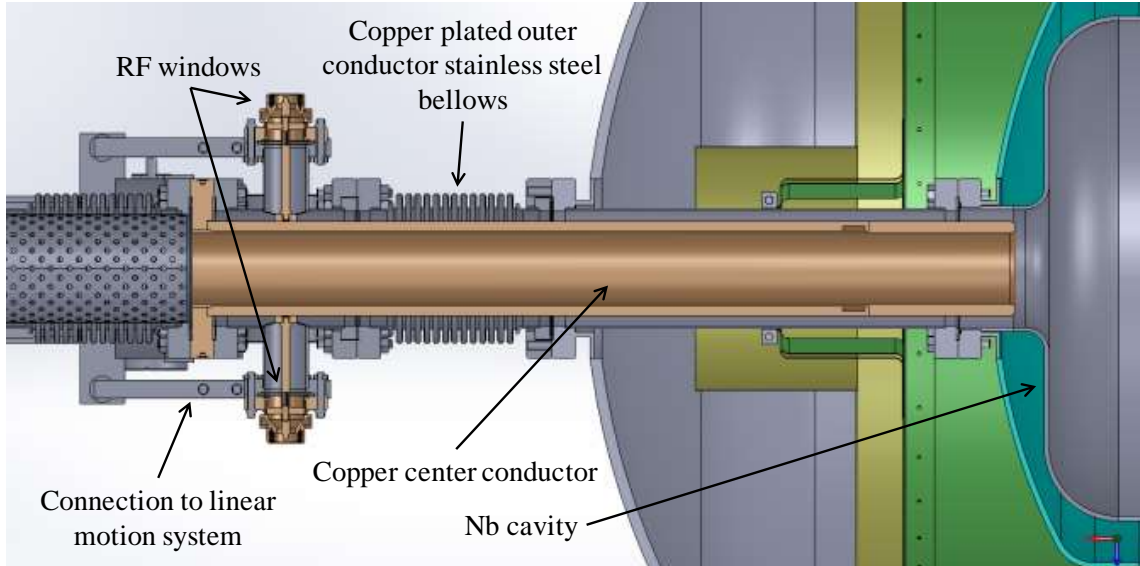


Figure 2-1. Cross-section of the FPC attached to the beam exit port (top view).

To enhance its ability to change the cavity's frequency, the FPC [7] is designed as a resonant quarter wavelength structure slightly detuned down, by ~ 2.8 MHz, from the cavity resonance. There are significant RF fields inside the normal-conducting coupler structure, which generate much larger losses than those inside the superconducting cavity, especially when fully inserted. Figure 2-2 shows the variation of the gun's FPC external quality factor versus the position of the coupling tube relative to the cavity (blue line). This result is calculated with CST Microwave Studio. The range of Q_{ext} is from 5×10^6 to 1.2×10^8 . The bunch charge can be supported by this FPC at full RF power is from 1 nC to 5 nC given the repetition rate of bunch of 78 kHz. Considering the gun voltage which 2 MV, the maximum beam power is 780 W.

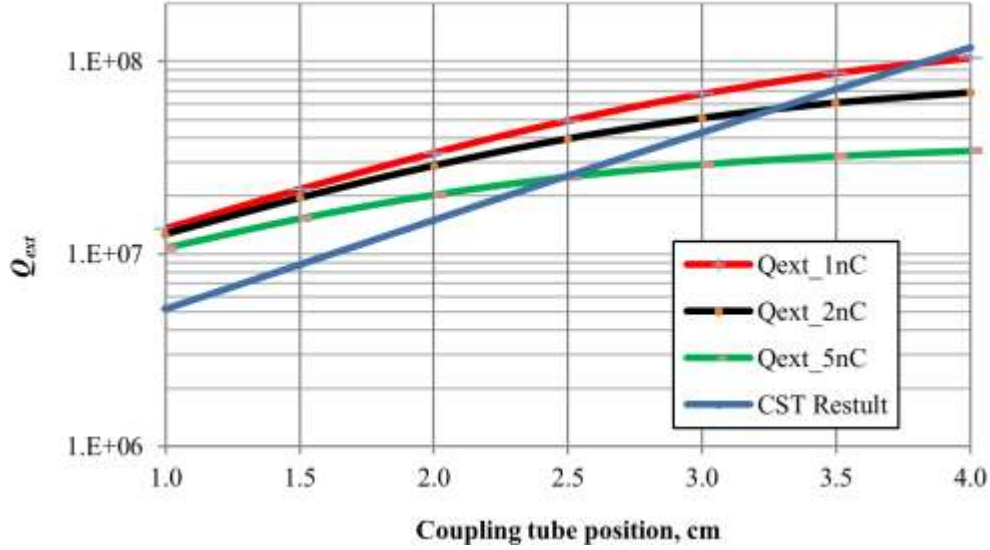


Figure 2-2. Q_{ext} versus position of the coupling tube.

Also shown in Figure 2-2 are the plots of the optimal (no reflection) external quality factor for three values of the bunch charge under the assumption that there is no parasitic detuning due to microphonic noise. The optimal external Q is calculated using the following equation [30]:

$$Q_{ext_opt} = \frac{Q_{cav}}{1 + \frac{P_{beam}}{P_{cav}}} = \frac{Q_{cav}}{1 + \frac{f_b \cdot q_b \cdot V_{acc} \cdot \cos \phi_b}{V_{acc}^2 / (R/Q \cdot Q_{cav})}} \quad (2-1)$$

where Q_{cav} is the cavity quality factor, which accounts for losses in the cavity walls, cathode stalk and FPC; P_{beam} is the power delivered to beam; P_{cav} is the power dissipated in the cavity, cathode stalk and FPC; f_b is the bunch repetition rate; q_b is the bunch charge; ϕ_b is the bunch phase. The bunch is assumed to be on crest for plots shown in Figure 2-2. As one can see from the plots, depending on the FPC position and bunch charge we would need Q_{ext} from 10^7 to 10^8 for optimal matching. By adjusting the position of the FPC we can also fine-tune the frequency of the cavity. The tuning range is shown in Figure 2-3.

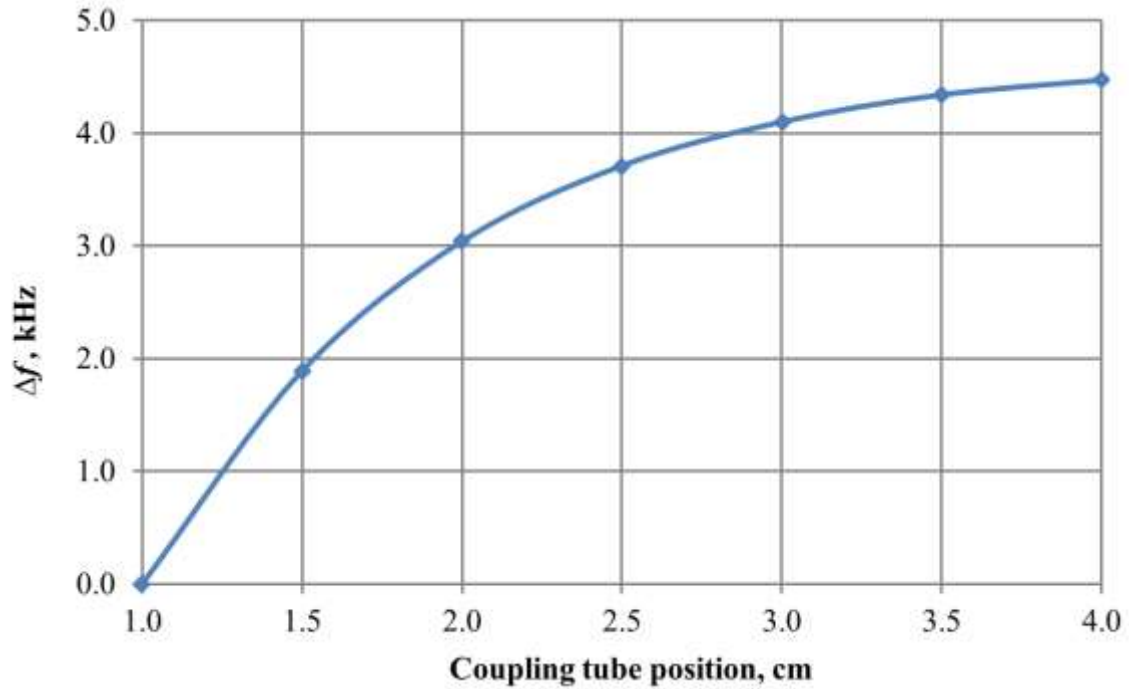


Figure 2-3. Frequency tuning by FPC.

2.2 Thermal Analysis

One important topic that deserves special consideration is the thermal load of the FPC due to the high RF power loss on its inner conductor. As given in Table 2-1, the maximum RF power loss on the inner conductor is nearly 900 W. Since the inner conductor connects only with the outer conductor at the far end of the FPC, the thermal conductance of the inner conductor is not enough to keep it at a low enough temperature. Figure 2-4 shows the temperature map of the FPC if there is no active water-cooling.

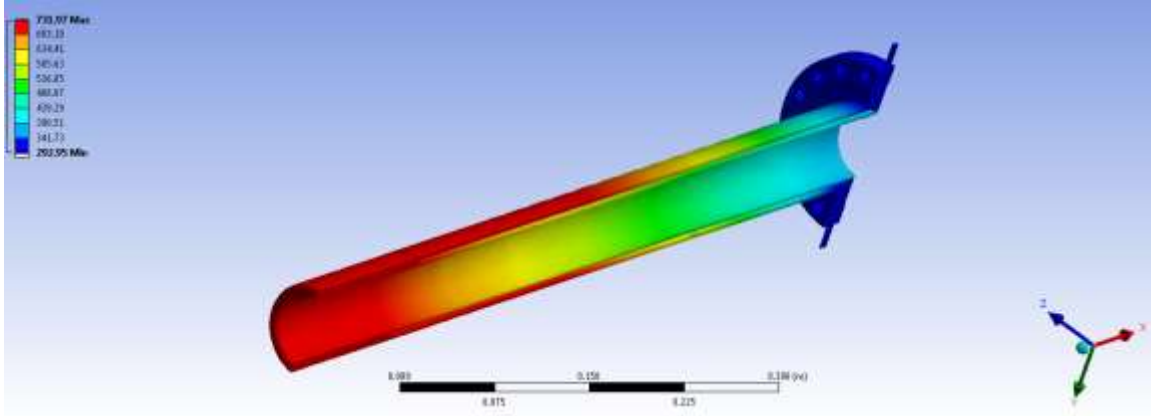


Figure 2-4. Temperature map of FPC without active water cooling.

As we can see the maximum temperature at the tip of the coupling tube is nearly 732 K. Given that the coupling tube and cold cavity wall overlap along a distance of 2 cm, the radius of the coupling tube is 4 cm and the emissivity of the gold plated surface is 0.02, we can use the Stefan-Boltzmann [59] equation to estimate the radiation thermal load:

$$\begin{aligned}
 P &= e\sigma A(T^4 - T_c^4) \\
 &= 0.02 \times 5.6703 \times 10^{-8} \times 2\pi \times 0.04 \times 0.02 \times (732^4 - 4.5^4) \quad (2-2) \\
 &= 1.6 \text{ W},
 \end{aligned}$$

where e is the emissivity of the tube, σ is Stefan-Boltzmann constant, T is the temperature of the tube and T_c is the temperature of the cavity. This value corresponds to a 13% increase in the thermal load of the cryosystem.

If we include the water cooling system, the temperature of the FPC can be well controlled at 293 K. Figure 2-5 shows the temperature map of FPC with active water cooling. The extra thermal load to the cryosystem from the tip of the FPC will be reduced to merely 0.25 W.

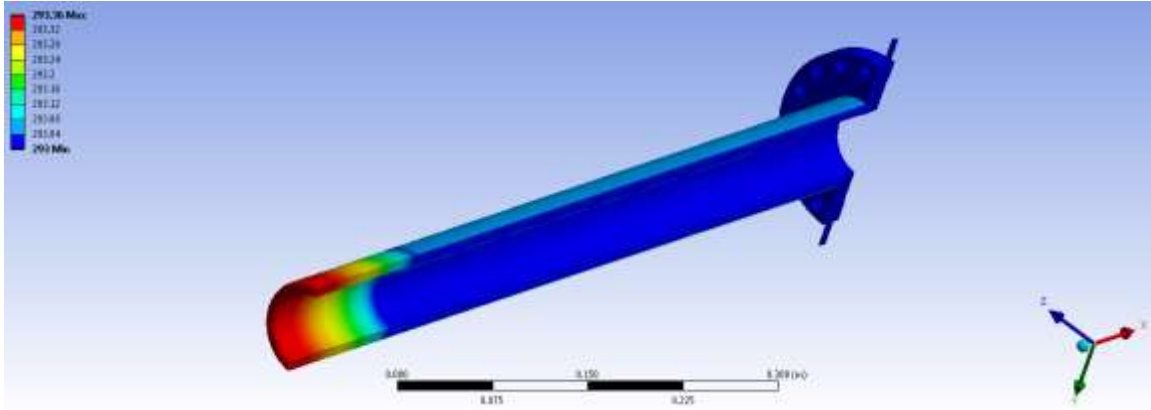


Figure 2-5. Temperature map of FPC with active water cooling.

In order to reduce the emissivity of the FPC inner conductor, we plated the copper tube with gold. The emissivity of copper and gold can be found in Table 2-2 [60]. We can clearly see the advantage of gold plating here. Even if the copper stays in its best condition, it still emits 50% more heat to the cryomodule. Considering the reactivity of the pure copper, it is difficult to prevent the oxidation to the surface which will be devastating to the liquid helium system. Therefore, we decided to gold plate the FPC to reduce the thermal emission as much as possible and eliminate the risk of an increase in the emissivity due to oxidation.

Table 2-2. Emissivity of copper and gold

Copper (highly polished)	0.03
Copper (Oxidized)	0.78
Gold (polished)	0.02

2.3 Multipacting Study

The multipacting simulation in FPC is performed with GPU code and Track3P. One multipacting barrier is found around 200 keV inside the FPC, which has the similar strength as the one we discussed in the cavity part. The location of the multipacting barrier is shown in Figure 2-6. This is a two-point first-order multipactor, and the enhanced counter function is around 10^7 . As a matter of fact, the gold plating on the FPC also reduces the MP strength due to the lower secondary electron yield as shown in Figure 2-7.

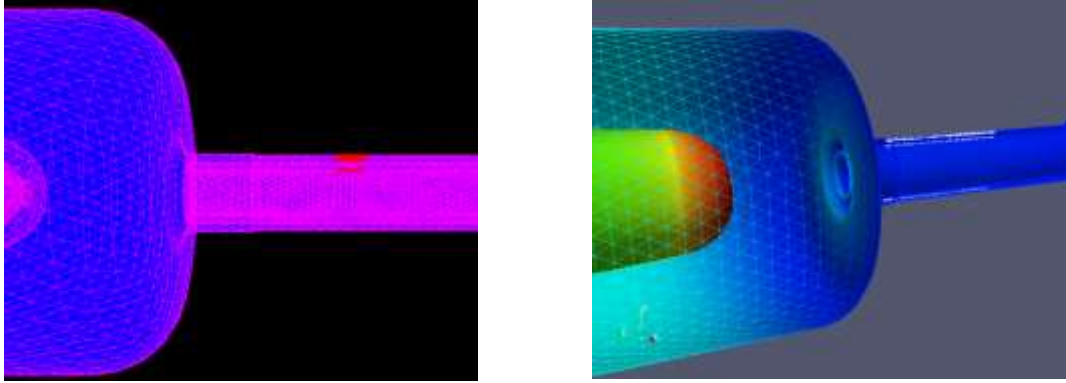


Figure 2-6. Location of MP in the 112 MHz FPC given by (Left) GPU code shown as red dots and (right) Track3P shown as white dots.

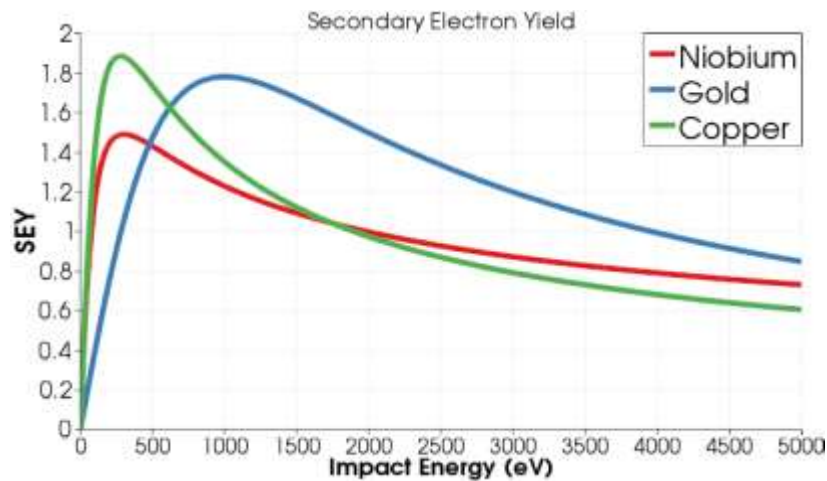


Figure 2-7. Secondary Electron Yield (SEY) of different materials

2.4 Summary

The 112 MHz injector was originally designed for a project with different requirements, and most of the cryomodule was already built for the original project. Therefore, we had to design a coaxial fundamental power coupler so that it is compatible with the existing hardware and capable of providing up to 780 W beam power. The thermal analysis of the FPC has been done with the help of CST and ANSYS. Active water-cooling was added after the simulation has shown a potentially dangerous heating due to RF power loss. The multipacting issue was also considered, and we were able to find a way of mitigating the problem by coating the surface of the inner conductor with gold.

3 Cathode and Insertion System

The photocathode's Quantum Efficiency (QE) drops significantly with temperature as reported [61,62]. To avoid this degradation, we designed 112 MHz SRF injector with a cathode operating at room temperature. K_2CsSb photoemission layer is deposited on the mirror-finished front surface of a 20-mm diameter molybdenum puck. The cathode resides inside a cathode stalk and is inserted into the injector when needed with a specially designed cathode manipulation system. The cathode stalk, which will be discussed in more detail later, is permanently installed inside the gun to avoid unnecessary particulate contamination to the cavity. The stalk serves two functions: 1) thermally insulates the cold QWR cavity from the cathode, and 2) provides an RF choke joint between the cathode and the cavity. The latter minimizes the transverse electric field near the cathode thus improving the beam quality. Detailed design considerations of the cathode stalk, cathode preparation, and manipulation are discussed below.

3.1 Cathode Stalk Design

The cathode-stalk design principles are similar to that described in [58]. The stalk is a hollow normal conducting structure made of copper-plated ($25\ \mu\text{m}$) stainless steel. It does not have direct physical contact with the cold center conductor of the cavity hence reducing the thermal load to the cavity and allowing the stalk to operate at room temperature. To reduce its emissivity, we coated the stalk with a very thin, about one micrometer, layer of gold. A Rexolite[®] "spider" is utilized to center the cantilevered stalk inside the cavity. However, this design allows the RF field to propagate out of the cavity into a gap between the stalk and the nose cone of the cavity. A half-wavelength stalk shorted at the far end makes a choke filter which reduces RF field penetration and minimizes the voltage drop between the cathode and the cavity's center conductor. The gap between the stalk and nose cone at the entrance of the cavity is only 3.56 mm. The stalk length was shortened to account for the capacitance created by this small gap. The resulting electric field distribution near the cathode is shown in Figure 3-1.

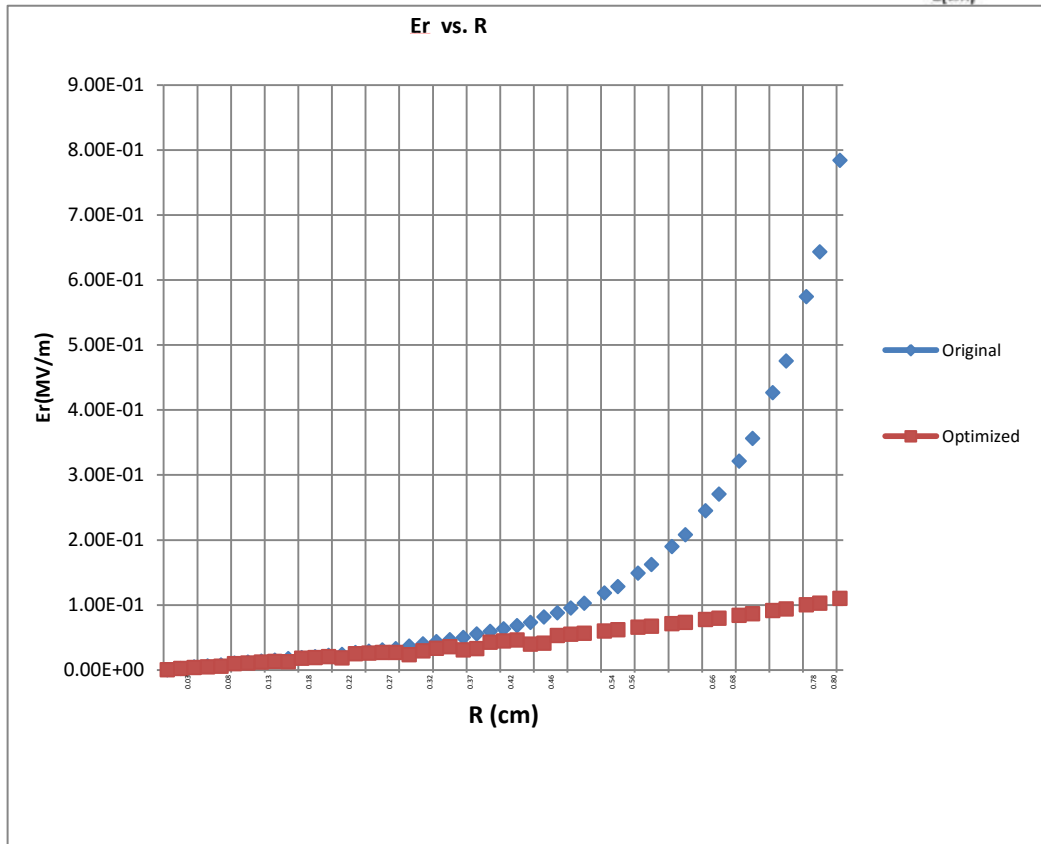
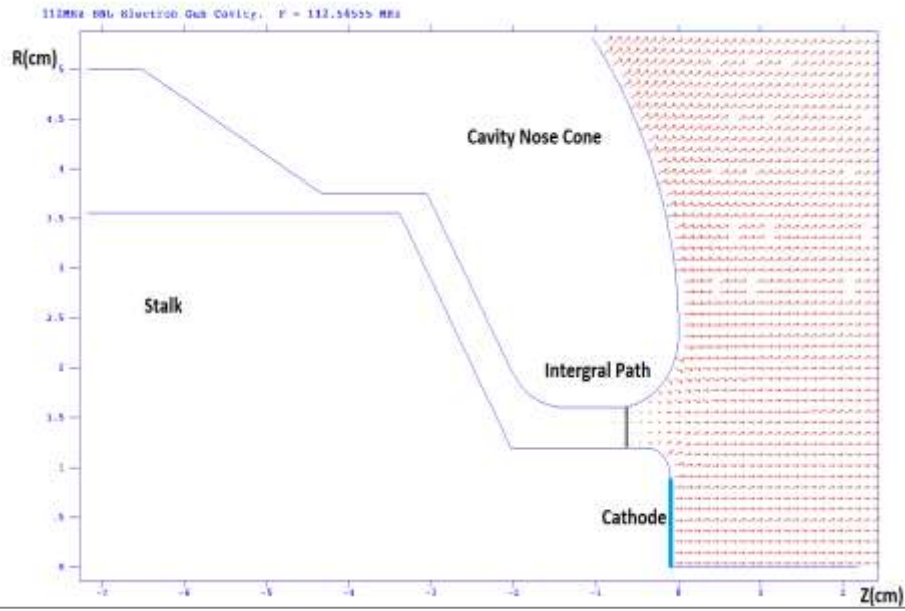


Figure 3-1. (Upper): Electric field distribution near the cathode surface and nose cone (gap between the cathode and stalk is not shown.); (Lower): Transverse field distribution on cathode before (♦) and after (■) optimization.

The transverse electric field on the cathode's surface was reduced by optimizing the length of the stalk as well as changing the position of the tip of the stalk relative to the cavity. By integrating along the solid black line shown in Figure 3-1, we can get the voltage drop between the cathode and cavity, which is only 0.22 kV at an accelerating voltage of 2 MV. So far we are talking about a cathode stalk that has the uniform diameter after the first chamfer behind the cathode tip. The RF power loss on this uniform stalk is 36 W.

Further reduction of RF losses from 36 W to 20 W on the stalk is achieved by introducing an impedance mismatch in the middle of the stalk (as shown in Figure 3-2), which creates a quarter wavelength impedance transformer.

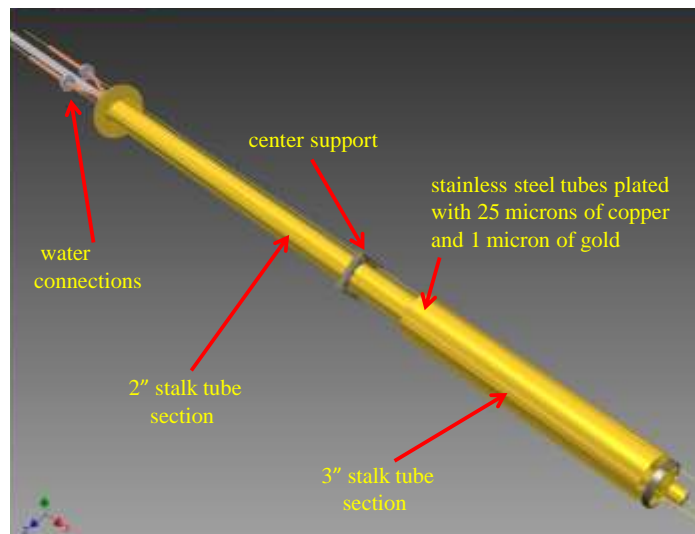


Figure 3-2. Cathode stalk assembly.

Since the shorted end has finite impedance Z_L , a real half wave stalk will propagate this impedance to the gap between the cathode and cavity as indicated by following lossless transmission line equation.

$$Z_{in} = Z_0 \frac{Z_L + jZ_0 \tan(\beta l)}{Z_0 + jZ_L \tan(\beta l)} \quad (3-1)$$

where Z_{in} is the impedance of the stalk seen by the cavity, Z_0 is the characteristic impedance of the stalk-cavity structure, j is the imaginary unit and $\beta = \frac{2\pi}{\lambda}$ and l is the length of the stalk. If $l = \frac{\lambda}{2}$ we will have $Z_{in} = Z_L$ which can be further reduced if we

introduce the impedance mismatch in the middle of the stalk. Consider the following schematic model:

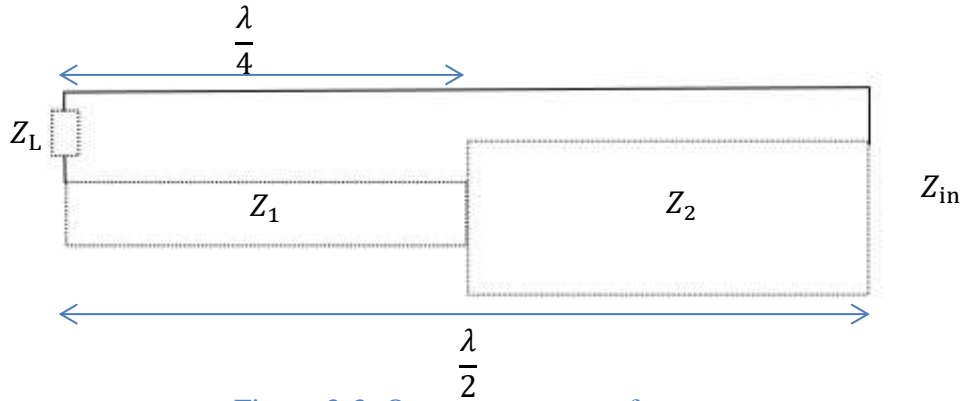


Figure 3-3. Quarter wave transformer.

In this scheme, the impedance Z_{in} is further reduced as

$$Z_{in} = Z_2 \frac{Z_1 \frac{Z_L + iZ_1 \tan(\beta l)}{Z_1 + iZ_L \tan(\beta l)} + iZ_2 \tan(\beta l)}{Z_2 + iZ_1 \frac{Z_L + iZ_1 \tan(\beta l)}{Z_1 + iZ_L \tan(\beta l)} \tan(\beta l)}, \quad l = \frac{\lambda}{4} \quad (3-2)$$

$$= \frac{Z_2^2}{Z_1^2} Z_L.$$

Since the characteristic impedance of coax is $60 \ln\left(\frac{R}{r}\right)$ where R is the radius of outer conductor and r is the radius of inner conductor, we always have $\frac{Z_2}{Z_1} < 1$. Therefore we reduced the impedance of the stalk seen by the cavity and consequently reduced the voltage drop between the stalk and the cavity. Another advantage of the impedance mismatch is the reduction of power loss on the alignment bellows, which could overheat if the RF loss stayed as high as the original number. The remaining heat is removed by cooling water. Table 3-1 compares RF losses on different parts of the stalk assembly (shown in Figure 3-4) between a uniform stalk design and a stalk with impedance transformation step.

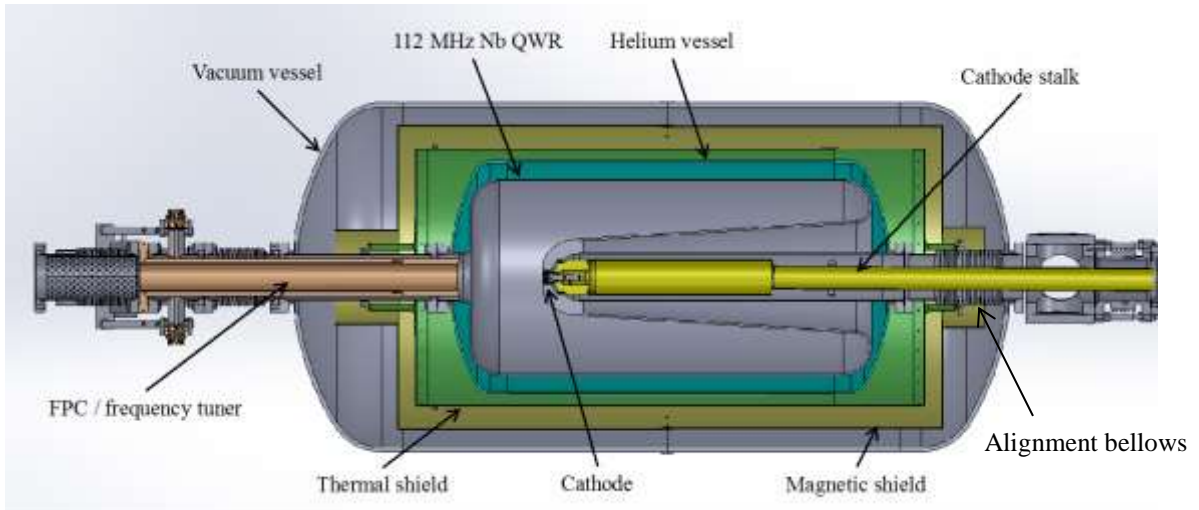


Figure 3-4. Assembly of 112 MHz SRF QWR Injector.

Table 3-1. Comparison of RF losses on a uniform stalk and a stalk with an impedance transforming step at an accelerating voltage of 2 MV.

Power losses	Uniform stalk	Stalk with impedance transformation step
On the stalk (Au)	36 W	20 W
On the bellows (Cu)	28 W	7 W
On the Nb pipe	120 μ W	31 μ W

3.2 Cathode Preparation

We chose K_2CsSb because of its high quantum efficiency (QE) in green light and long lifetime in a 10^{-10} Torr scale vacuum environment. Using 532 nm green light makes it easier to get a high-power laser and to shape the laser pulses spatially and temporally. The cathodes are prepared in a deposition chamber described in [63] and shown in Figure 3-5. The deposition chamber is equipped with a residual gas analyzer (RGA), a quartz crystal film thickness monitor, and multiple viewports for observation and laser illumination of the cathode. Alkali metal dispenser sources (SAES getter 6 mg K and 10.8 mg Cs) and Antimony (Goodfellow 99.999% purity pellets) are used for the deposition. These sources are installed separately and inserted through gate valves into the deposition chamber as needed during evaporation. A boron nitride resistive heater is used to control the substrate temperature over the range of 20°C to 500°C.

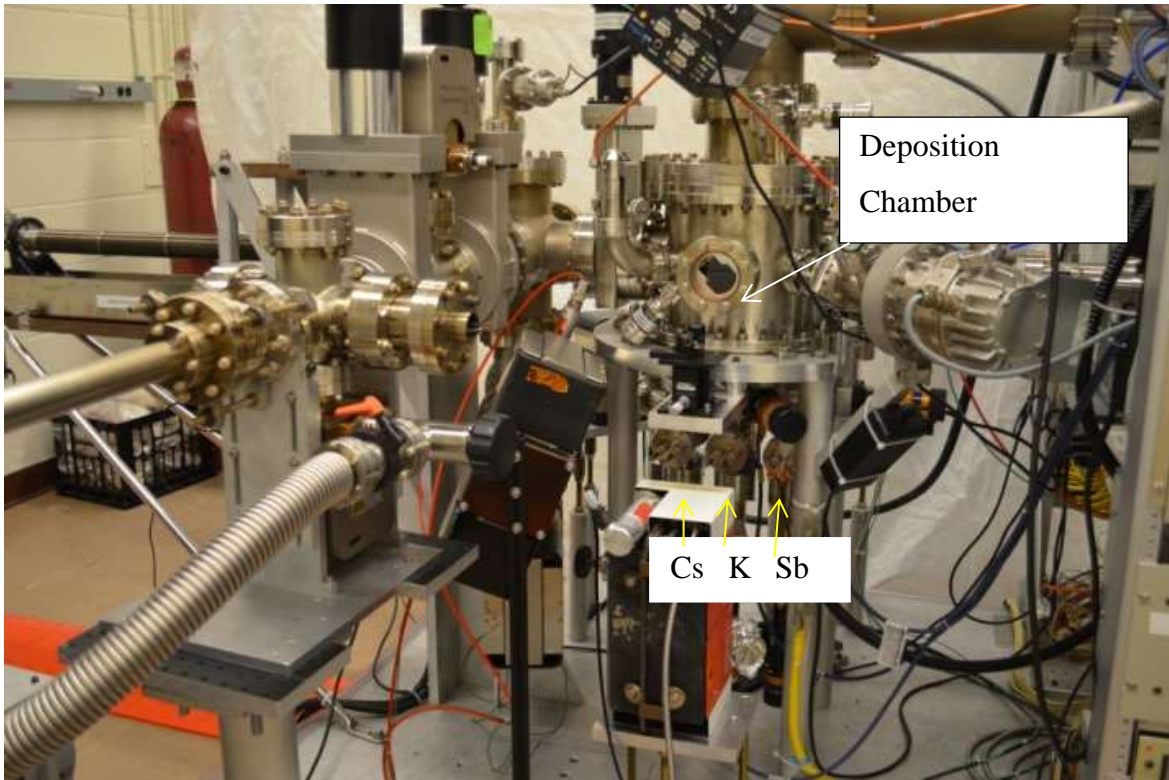


Figure 3-5. Multi-alkali deposition system for the 112 MHz gun.

The cathode material is deposited onto a high purity molybdenum puck. The puck's front surface is mirror-finished to 2 nm RMS roughness to reduce the roughness-induced emittance [64, 65, 66, 67]. Figure 3-6 shows molybdenum pucks before cathode deposition. We use standard cathode deposition procedure, which is discussed in [68]. Two cathodes were prepared with an initial QE at 6.5% and 8%, respectively.



Figure 3-6. Photograph of polished molybdenum pucks before deposition of the photoemission layer.

3.3 The Cathode Insertion System

The cathode insertion system is depicted in Figure 3-7. The insertion system with up to three cathodes inside is connected to the gun via a load lock. The cathode diagnostic system allows us to measure the cathode's QE before insertion. The cathode end assembly, attached to the manipulator arm, is shown in Figure 3-8. The manipulator arm has three centering standoffs with rolling ceramic wheels, which prevent damage to the cathode on insertion and limit generation of particulates. Two grooves on the cathode puck allow manipulation with special spring "forks". Finally, gold plated RF spring finger contacts ensure that EM field does not propagate into the cathode stalk.

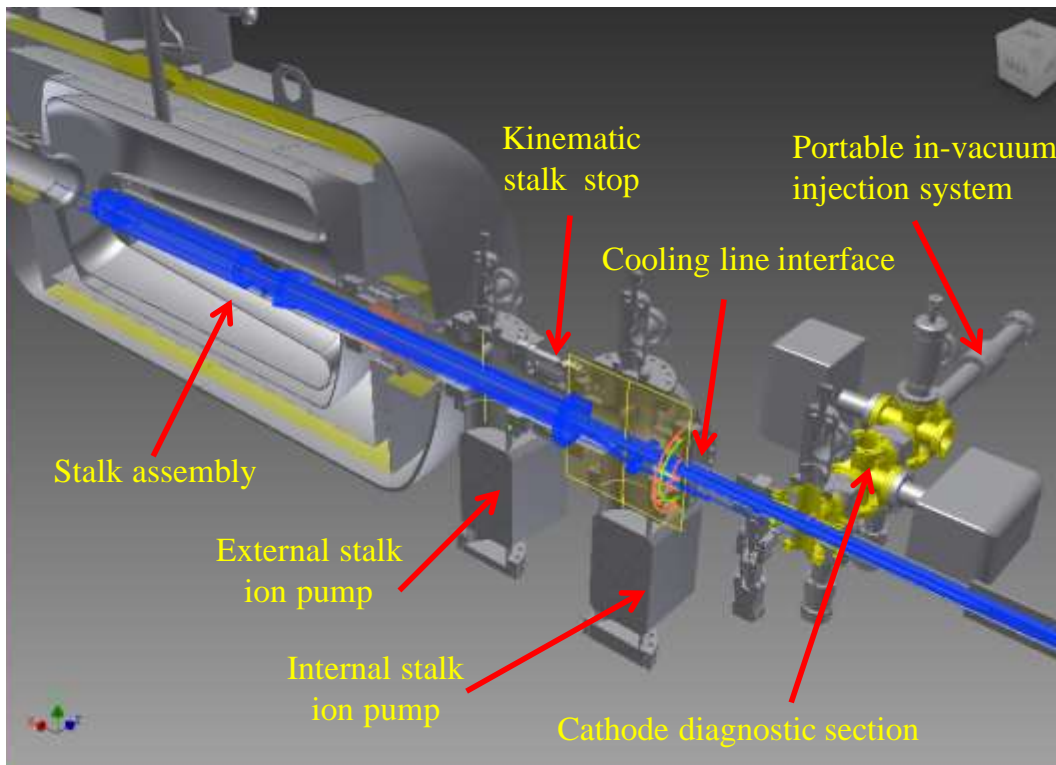


Figure 3-7. Cross-sectional view of the cathode insertion system.

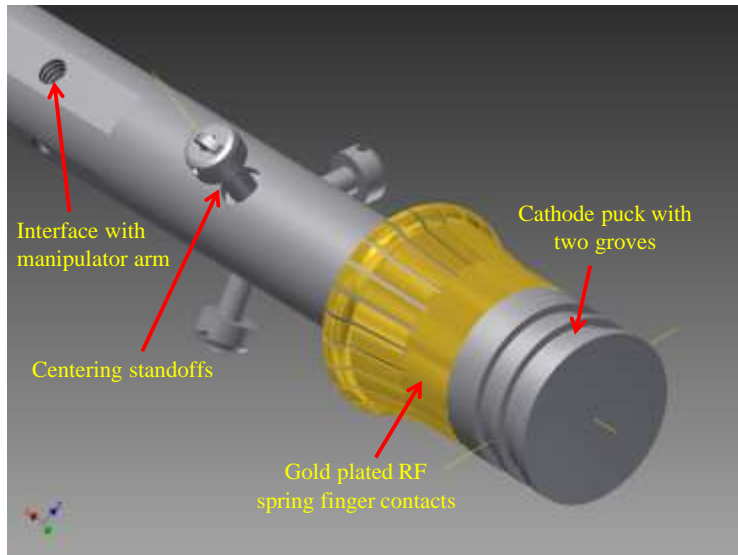


Figure 3-8. Cathode end assembly.

3.4 Multipacting Study

The multipacting simulations done by GPU code and Track3p show that there is a relatively strong MP barrier inside the gap between cathode stalk and the outer conductor. The multipacting begins to build up at around 600 kV gun voltage (shown in Figure 3-9) and persists until up to 1 MV gun voltage. The strength of this MP is about 4 orders of magnitude higher than the one in the FPC. Gold plating helps to reduce the maximum enhanced counter function. If TiN coating were used, the MP could be suppressed even further as shown in Figure 3-10.

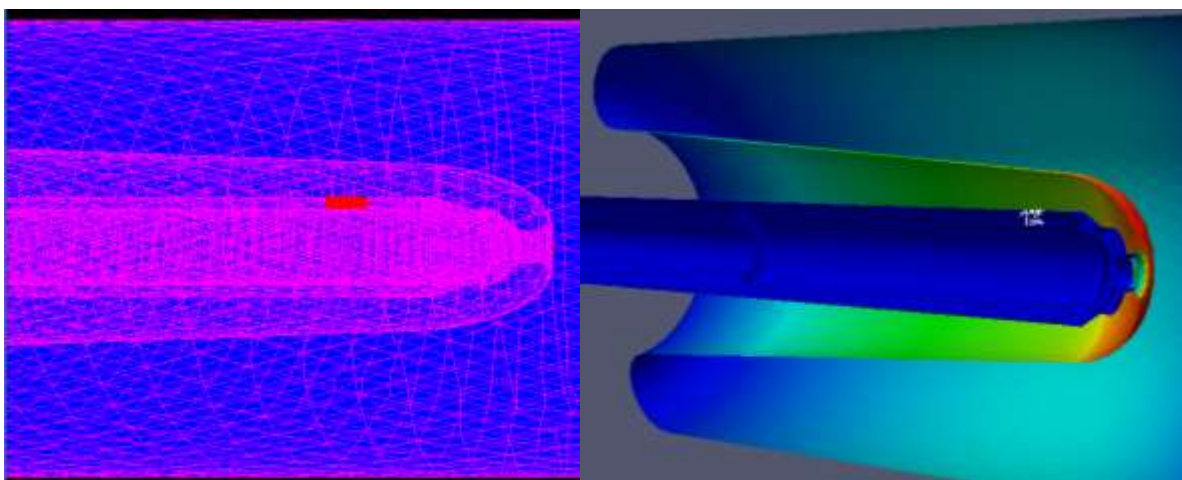


Figure 3-9. Multipactors between the cathode stalk and the cavity. The MP appears at around 600 kV gun voltage.

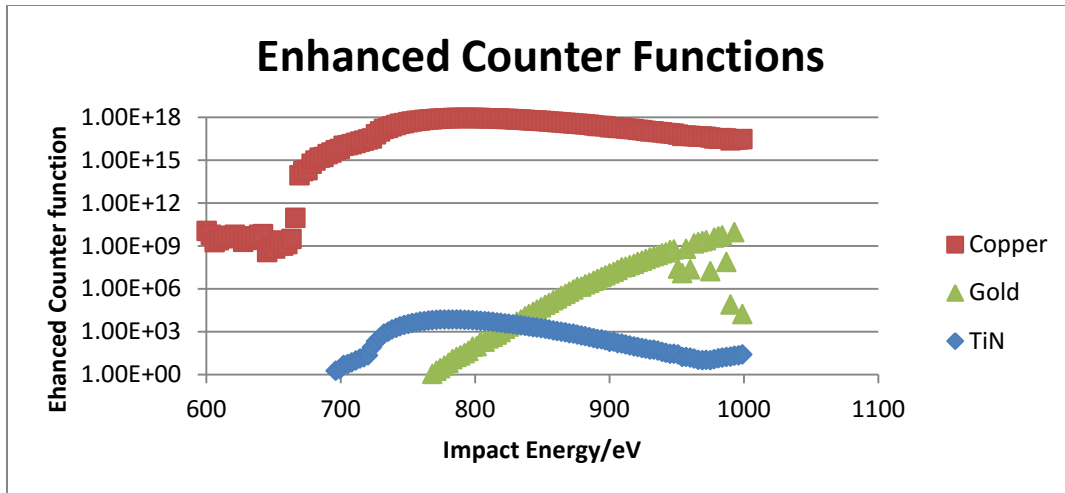


Figure 3-10. Enhanced counter function of MP in cathode stalk with copper surface, gold plating and TiN coating.

3.5 Summary

We can routinely grow K_2CsSb cathode with QE better than 5% in the deposition chamber at the Instrumentation Department at BNL. To preserve the QE of cathode we need to, ideally, keep it under vacuum better than 1×10^{-10} Torr. Therefore, we built a cathode transport system which can take up to three cathodes from the deposition chamber to the 112 MHz injector in RHIC tunnel while keeping the vacuum under 1×10^{-10} Torr. We also discussed the design and test result of a half-wavelength choke structure cathode stalk in this chapter. The stalk allows us to operate the cathode at room temperature so that the QE at the wavelength of 532 nm will not suffer degradation due to cryogenic temperature. The design of the stalk also reduces the voltage drop between the cathode and the cavity because of the choke structure. We also showed an impedance mismatch which further reduces the impedance of the choke structure seen by the cavity and consequently reduce the voltage drop in the cathode-cavity gap and minimizes the heat load on the stalk. The multipacting issue is the main problem for this design. We tried to reduce the enhanced counter function by coating the stalk with gold. This also reduces the emissivity of the surface hence reduces the thermal load from radiation to the cryosystem. Simulation results show promising improvement by this surface treatment. Further improvement to this issue can be achieved by coating the surface with TiN.

4 Beam Dynamics Simulation

The electron beam is generated by the multi-alkali photocathode K_2CsSb under the illumination of 532 nm laser. The initial bunch length in time domain is determined by the laser pulse. The typical quantum efficiency of the cathode is on the order 5%. And the bunch charge deliverable by 112 MHz can be as high as 5 nC. Three parameters are of most interest to the CeC PoP application: The peak current, the normalized emittance and the energy spread of the beam [1, 69, 70]. The peak current is simply the bunch charge divided by the bunch duration, and energy spread is just the standard deviation of the energy of particles in a bunch normalized to the mean energy. The emittance is a concept that deserves a little more explanation.

4.1 Emittance of a Beam

The emittance of the beam is a figure of merit used regularly in the accelerator community to describe the quality of the beam. The emittance is of great importance in many applications such as colliding beams, free electron laser, electron cooling, etc. We use the statistical definition here. The definition of the emittance is [71]:

$$\epsilon_u = \sqrt{\langle x^2 \rangle \langle x'^2 \rangle - \langle x x' \rangle^2}, \quad (4-1)$$

where the bracket $\langle \ \rangle$ means taking the average of the variable in it. This definition of the emittance represents the statistical area of the x - x' phase space occupied by the beam. Here x is the transverse coordinate of the particle and x' is the diverging angle of the particle:

$$x' = \frac{p_x}{p_z}. \quad (4-2)$$

As one can see, the geometrical emittance ϵ_u defined in this way will diminish rapidly when the electron is accelerated from rest to near speed of light. On the other hand the normalized emittance is a conserved quantity in a Hamiltonian system:

$$\epsilon_n = \epsilon_u \beta \gamma, \quad (4-3)$$

where β and γ are Lorentz factors calculated from the average energy of the bunch and ϵ_u is the unnormalized, or geometrical emittance defined in equation (4-1).

The emittance is very important in many applications. For example in Free Electron Laser facility, to get transverse coherent radiation the un-normalized emittance must satisfy the following condition:

$$\epsilon_u < \frac{\lambda_{\text{FEL}}}{4\pi}. \quad (4-4)$$

Recalling the divergence of laser [72]

$$\theta = \frac{\lambda}{\pi w_0}, \quad (4-5)$$

where w_0 is the waist size of the laser beam and λ is the wavelength of the laser. We can interpret the physical meaning for the requirement in (4-4) as: the emittance of the electron beam needs to be smaller than $\frac{1}{4}$ of the laser emittance [73].

There are many sources that determine the value of the emittance [74]. The most important three components of the emittance as produced in an RF injector are the thermal emittance ϵ_{th} , The RF induced emittance ϵ_{RF} and the space charge induced emittance ϵ_{SC} . Assuming that these emittances are uncorrelated, the total emittance can be calculated as follows:

$$\epsilon = \sqrt{\epsilon_{\text{th}}^2 + \epsilon_{\text{RF}}^2 + \epsilon_{\text{SC}}^2 + \dots} \quad (4-6)$$

The thermal emittance is the emittance of the beam right after the bunch is generated from the surface of the cathode, thus it is a fundamental limit on the magnitude of the total emittance. In order to discuss the thermal emittance, we need to have a closer look at the mechanism of photoemission of electrons from a photocathode.

The photoemission process can be decomposed into three major steps according to the model first proposed by Spicer [75, 76]. In the first step, the photons excite the electrons in the photocathode material. In a semiconductor this process excites electrons from the valence band to the conduction band. In the second step, the excited electrons drift to the surface of the cathode, accompanied by various types of scattering events. The third step is the emission step during which the electrons overcome the potential barrier between the

cathode and vacuum and exit the cathode. One simple model of the process is illustrated in Figure 4-1.

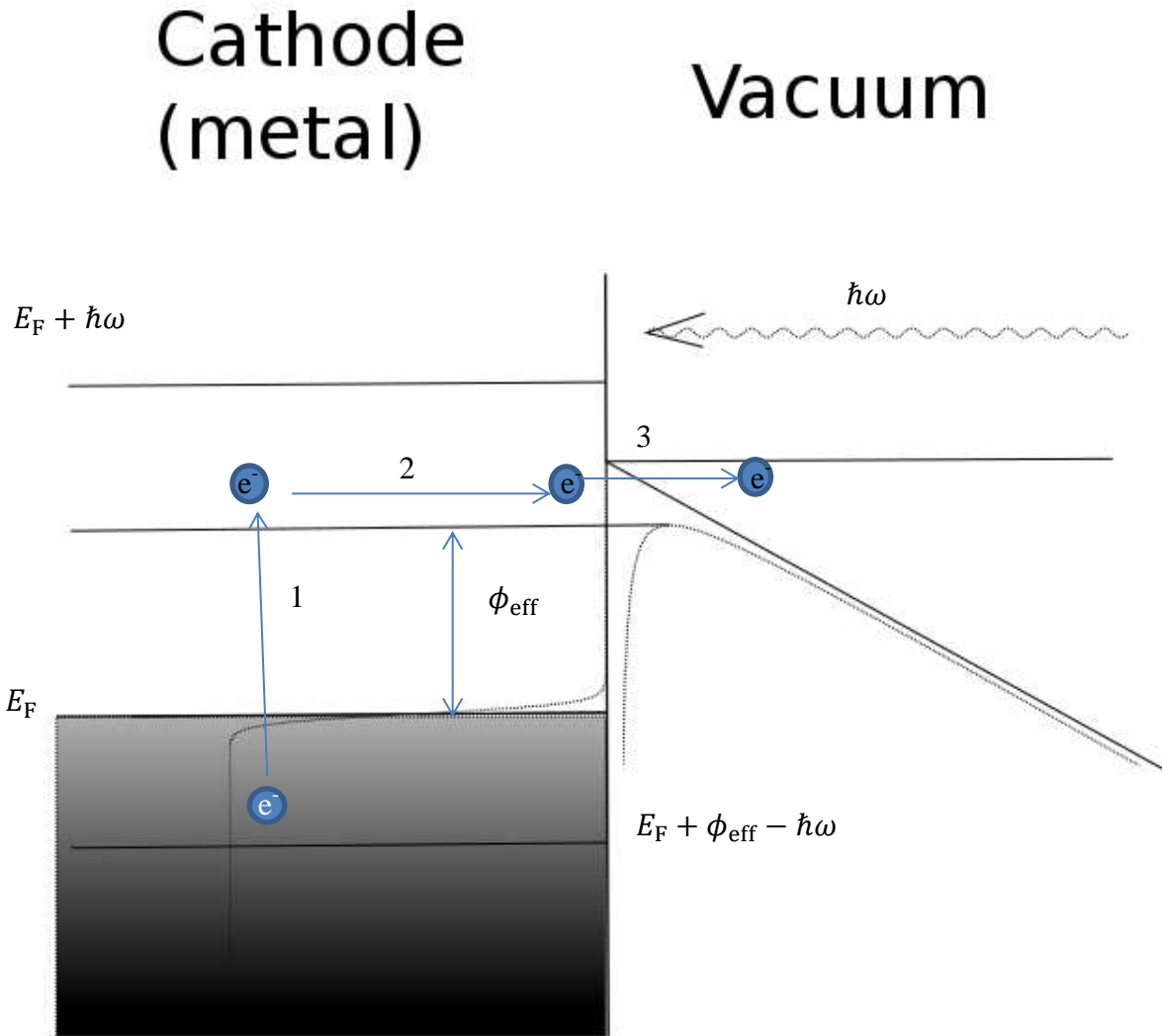


Figure 4-1. Three-step model for the metal cathode.

In the first step, the bound electrons absorb the energy of the photons. We assume only the portion of electrons that have energy higher than the cathode-vacuum potential barrier right after the excitation can escape the barrier. Then this portion can generally be written as the following:

$$P_1 = \int_{E_F + \phi_{\text{eff}} - \hbar\omega}^{\infty} dE N(E + \hbar\omega) (1 - f_{\text{FD}}(E + \hbar\omega)) N(E) f_{\text{FD}}(E). \quad (4-7)$$

E is the electron energy, E_F is the Fermi level of the cathode material, ϕ_{eff} is the effective barrier height between the cathode and vacuum, $\hbar\omega$ is the photon energy. Equation (4-7) is just the convolution of electron distribution in the initial stage $N(E)$ and available states distribution in the final stage $N(E+\hbar\omega)$, with f_{FD} as the Fermi-Dirac distribution. In the second step the electrons go through different scattering processes and thermalize to the final distribution rather quickly, at a time of the order of a picosecond. The third step is the one that we interested the most, which is directly related to the thermal emittance of the beam. When the electrons reach the barrier between the cathode and vacuum, they must have enough energy to escape. Under a classical approximation, the momentum of the electron must satisfy the following condition:

$$\frac{p_{\text{normal}}^2}{2m_{\text{eff}}} > E_F + \phi_{\text{eff}}, \quad (4-8)$$

where p_{normal} is the normal component of the momentum of the electron, m_{eff} is the effective mass of the electron.

Assume the angle between the normal direction of the surface and the direction of the momentum of the electron is θ , then we have the maximum incident angle under which the electron can successfully emit satisfies

$$\cos(\theta_{\text{max}}) = \frac{p_{\text{normal}}}{p_{\text{total}}} = \sqrt{\frac{E_F + \phi_{\text{eff}}}{E + \hbar\omega}}. \quad (4-9)$$

Here p_{total} is the amplitude of the momentum of electron at emission surface.

After obtaining this, we can calculate the average square transverse momentum as

$$\langle p_x^2 \rangle = \frac{\iiint g(E, \theta, \phi) p_x^2 dE d(\cos\theta) d\phi}{\iiint g(E, \theta, \phi) dE d(\cos\theta) d\phi}. \quad (4-10)$$

The g -function depends on the distribution right after the emission, for example in a simplified model for metal we can use step function for energy distribution as the approximation to the Fermi-Dirac distribution at room temperature.

$$g = (1 - f_{\text{FD}}(E + \hbar\omega))f_{\text{FD}}(E) \approx (1 - \Theta(E + \hbar\omega))\Theta(E), \quad (4-11)$$

where

$$\Theta(x) = \begin{cases} 1, & x \leq E_{\text{F}} \\ 0, & x > E_{\text{F}} \end{cases} \quad (4-12)$$

The integration limits in Equation (4-11) are determined in previous discussions.

Plugging the g -function and the limits into Equation (4-11) we get

$$\begin{aligned} \langle p_x^2 \rangle &= \frac{2m \int_{E_{\text{F}} + \phi_{\text{eff}} - \hbar\omega}^{E_{\text{F}}} dE \int_{\sqrt{\frac{E_{\text{F}} + \phi_{\text{eff}}}{E + \hbar\omega}}}^1 d(\cos \theta) \int_0^{2\pi} d\phi (E + \hbar\omega) \sin^2 \theta \cos^2 \phi}{\int dE \int d(\cos \theta) \int d\phi} \quad (4-13) \\ &= m \frac{\hbar\omega - \phi_{\text{eff}}}{3}. \end{aligned}$$

And the normalized divergence is [77]

$$\Delta_{x'} = \beta\gamma\sigma_{x'} = \beta\gamma \sqrt{\frac{\hbar\omega - \phi_{\text{eff}}}{6 E_{\text{k}}}} \approx \sqrt{2(\gamma - 1)} \sqrt{\frac{\hbar\omega - \phi_{\text{eff}}}{6 E_{\text{k}}}} = \sqrt{\frac{\hbar\omega - \phi_{\text{eff}}}{3mc^2}}, \quad (4-14)$$

where E_{k} is the kinetic energy of the electron.

Hence, the normalized thermal emittance is

$$\epsilon_{\text{th}} = \sigma_x \sqrt{\frac{\hbar\omega - \phi_{\text{eff}}}{3mc^2}}. \quad (4-15)$$

We notice that the emittance is proportional to the square root of the difference between photon energy and effective barrier height, this is one of the reasons why people prefer longer wavelength laser (green, even IR) in photocathode over UV when emittance is a more critical parameter.

In gun operations, we sometimes run the cathode at the Space Charge Limited (SCL) scenario to get as much charge as possible. In this case, the space charge field E_z can be obtained easily by Gauss's law

$$E_z = \frac{\sigma_{SCL}}{\epsilon_0}, \quad (4-16)$$

where σ_{SCL} is the charge density under space charge limit, ϵ_0 is vacuum permittivity. Assume the uniform distributed in transverse direction, and the beam has a radius equal to a , then

$$a = \sqrt{\frac{Q_{\text{bunch}}}{\epsilon\pi E_z}}, \quad (4-17)$$

where Q_{bunch} is the total charge in a bunch. The space charge limited emittance can be found as

$$\epsilon_{SCL} = \sqrt{\frac{Q_{\text{bunch}}(\hbar\omega - \phi_{\text{eff}})}{4\pi\epsilon_0 mc^2 E_z}}. \quad (4-18)$$

Another important source of emittance is the RF cavity induced emittance. This emittance is the result of a time-dependent transverse kick the bunch receives from the RF field at the exit of the gun cavity. The transverse RF field at the axis can be evaluated by Panofsky-Wenzel theorem [78]:

$$E_r = -\frac{r}{2} \frac{\partial}{\partial z} E_z, \quad cB_\theta = \frac{r}{2c} \frac{\partial}{\partial t} E_z, \quad (4-19)$$

where E_r , E_z are the transverse and longitudinal components of the electric field and B_θ is the azimuthal components of the magnetic field. Assume the form of longitudinal electric field is $E_z = E_0(z) \cos(kz) \sin(\omega t + \phi_0)$, the transverse kick of the RF field to the beam is

$$\begin{aligned}
F_r &= er \left(-\frac{1}{2} \frac{dE_0(z)}{dz} \cos(kz) \sin(\omega t + \phi_0) \right. \\
&\quad - \frac{k}{2} E_0(z) \sin(kz) \sin(\omega t + \phi_0) \\
&\quad \left. - \frac{\beta}{2c} E_0(z) \cos(kz) \omega \cos(\omega t + \phi_0) \right) \\
&= er \left(-\frac{1}{2} \frac{dE_0(z)}{dz} \cos(kz) \sin(\omega t + \phi_0) \right. \\
&\quad - \frac{k}{2} E_0(z) \sin(kz) \sin(\omega t + \phi_0) \\
&\quad - \frac{\beta}{2c} E_0(z) \cos(kz) \omega \cos(\omega t + \phi_0) \tag{4-20} \\
&\quad - \frac{\beta}{2} \frac{dE_0(z)}{dz} \sin(kz) \cos(\omega t + \phi_0) \\
&\quad \left. + \frac{\beta}{2} \frac{dE_0(z)}{dz} \sin(kz) \cos(\omega t + \phi_0) \right) \\
&= er \left(-\frac{1}{2} \frac{dE_0(z)}{dz} \cos(kz) \sin(\omega t + \phi_0) \right. \\
&\quad - \frac{1}{2c} \frac{d}{dt} (E_0(z) \sin(kz) \cos(\omega t + \phi_0)) \\
&\quad \left. + \frac{\beta}{2} \frac{dE_0(z)}{dz} \sin(kz) \cos(\omega t + \phi_0) \right).
\end{aligned}$$

The second term goes to zero in the integrated momentum change. The first and third term are only none zero when there is a jump in $E_0(z)$. Assume step shape of E_0 at the exit of the cavity, we can get the transverse momentum kick as

$$\Delta p_r = r \frac{eE_0}{2mc^2} (\beta \cos(kz_e) \sin(\omega t_e + \phi_0) - \sin(kz_e) \cos(\omega t_e + \phi_0)). \tag{4-21}$$

Where z_e is the z coordinate of cavity exit and t_e is the time when electron leaves the cavity.

Assuming the $\beta = 1$ we have

$$\Delta p_r = r \frac{eE_0}{2mc^2} \sin(\omega t_e + \phi_0 - kz_e) = r \frac{eE_0}{2mc^2} \sin \phi_e. \quad (4-22)$$

Namely, the transverse kick is related to the exit phase $\phi_e = (\omega t_e + \phi_0 - kz_e)$ of the particle.

For a Gaussian beam with RMS bunch length equal to σ_{ϕ_e} exiting the cavity at $\phi_e = \frac{\pi}{2}$, the RF induced emittance is [79, 80]

$$\epsilon_{\text{RF}} = \frac{eE_0}{2mc^2} \langle x^2 \rangle \frac{\sigma_{\phi_e}^2}{\sqrt{2}}. \quad (4-23)$$

Recall Equation (4-6), the third source of emittance is the space charge induced emittance. Consider the bunch that under laminar flow, which means the trajectories of the particles never cross. We slice the bunch into short slices and consider the slices independently. When the bunch is long, namely the aspect ratio r/L is small in its rest frame, we have the transverse electric field as

$$E_r = \frac{Ir}{2\pi\epsilon_0 R^2 v}, \quad (4-24)$$

where I is the current of the beam, r is the transverse coordinate, R is the size of the slice, v is the velocity of the electrons.

The equation of motion of electron under the space charge is

$$\gamma m \frac{d^2}{dt^2} r = \frac{eE_r}{\gamma^2} = \frac{Ir}{2\pi\epsilon_0 R^2 v}. \quad (4-25)$$

Under the laminar flow assumption and ignoring the thermal emittance, we can change r directly to R to get the envelope equation as

$$\gamma m R'' = \frac{K_{\text{sc}}}{R}, \quad (4-26)$$

where $K_{\text{sc}} = \frac{I}{2\pi\epsilon_0 v}$ is the space charge effect induced defocusing strength. In order to counter this defocusing effect, a straightforward way of thinking is to introduce a focusing term K_f to compensate this effect.

$$R'' + K_f R - \frac{K_{sc}}{R} = 0. \quad (4-27)$$

One can easily notice the non-oscillatory condition

$$K_f R = \frac{K_{sc}}{R}. \quad (4-28)$$

If we inject the beam into the focusing channel under the matched initial condition, which is called “the invariant envelope”,

$$R'_0 = 0, R_0 = \sqrt{\frac{K_{sc}}{K_f}}, \quad (4-29)$$

the slice envelope will not oscillate. If the injection is slightly mismatched relative to the invariant envelope, we can use the small deviation perturbation:

$$R = R_0 + \delta R, \quad (\delta R)'' + \delta R \left(K_f + \frac{K_{sc}}{R_0^2} \right) = 0 \text{ with } R_0 = \sqrt{\frac{K_{sc}}{K_f}}, \quad (4-30)$$

$$(\delta R)'' + 2K_f \delta R = 0.$$

The small deviation will oscillate around the equilibrium envelope with frequency corresponding to $2K_f$. One favorable feature of this type of compensation is the oscillation frequencies of different slices are all the same, therefore if we align the slices together in phase space they will periodically realign later on. This technique is called “emittance compensation”.

The next step will be injecting the beam into the LINAC part to freeze the emittance. Again an invariant envelope exists so that the slices of the injected beam will stay aligned or, under small deviation the slices will undergo oscillation and periodically come back to minimum emittance. Practically we inject the beam at the beam waist, and the RF kick at cavity entrance serve as the final focusing that aligns the slices in phase space. The discussion of this topic is beyond the scope of this thesis and can be found in reference [81].

4.2 Beam Simulation

Figure 4-2 shows the beamline layout (not drawn to scale). There are primarily three objectives of the beam simulation, the first one is to minimize the transverse emittance of the beam, the second one is to minimize the energy spread of the beam and the third one is to maximize the peak current.



Figure 4-2. Schematic layout of 112 MHz injector.

The parameters need to be considered in the optimization is listed in Table 4-1.

Table 4-1. Parameter ranges for 112 MHz injector

Parameter	Range
112 MHz phase	$0 \sim \pi$
500 MHz Cavity Voltage	0~300 kV
500 MHz Cavity phase	$-\frac{\pi}{2} \sim \frac{\pi}{2}$
Solenoid 1~6	0~0.1 T
704 MHz Cavity Voltage	16~20 MV
704 MHz Cavity Phase	$0 \sim \pi$

The major objectives of the optimization are shown in Table 4-2. This is a multi-objective multi-parameter optimization problem. There is an additional requirement on the beam, which is to have a flat top in the longitudinal profile after the

compression so that the efficiency of Coherent Electron Cooling process can be maximized.

Table 4-2. Objectives of optimization of 112 MHz injector

Objectives	Value
Transverse Emittance	$5 \pi \text{mm mrad}$
Energy Spread	0.1%
Peak Current	60~100 A

We have a 10 dimensional parameter space to cover, the resolutions of each dimension were chosen as following:

- For 500 MHz cavity voltage: step size = 15 kV;
- For 704 MHz cavity voltage: step size = 100 kV
- For cavity phase: step size = 2 degree;
- For solenoid strength: step size = 0.01 T;

Therefore, the total number of nodes in the parameter space is

$$\frac{300 \text{ kV}}{15 \text{ kV}} \times \frac{20 \text{ MV} - 16 \text{ MV}}{100 \text{ kV}} \times \left(\frac{180}{2}\right)^3 \times \left(\frac{0.1}{0.01}\right)^6 \approx 5.8 \times 10^{14}.$$

It is impossible, and not necessary, to traverse the whole parameter space. The author chose a genetic algorithm to search for the solution [82, 83, 84, 85].

The genetic algorithm wraps around the ASTRA code, and works as follows:

1. Randomly generate the initial generation of samples.
2. Run ASTRA on each of the samples to get the 3-d objective vectors.
3. Evaluate the objective vectors to find the set of non-dominated samples. The term non-dominated can be understood as following:

Assume we have n objectives and we have m samples in a generation, f_{ij} represents the j th objective of i th sample. We say sample A is dominated by sample B if

$$\forall i \in [1, n], f_{Ai} \geq f_{Bi},$$

and $\exists j \in [1, n]$ such that $f_{Aj} > f_{Bj}$,

here we adopted the tradition where smaller objective means a better solution. Thus, a non-dominated sample means we cannot find any other sample that dominates it. We keep all the non-dominated samples as the approximation of the Pareto-front (the ensemble of non-dominated samples if $m \rightarrow \infty$) of the problem [86]. The rest of the samples will be eliminated from the pool. If we find a sample that satisfies all the criteria listed in Table 4-2, we end the process. Otherwise, if the total number of generations exceeded 100, we also end the process. If neither of the above conditions is met, we continue.

4. Generate the next generation of samples based on the samples that survived from the previous generation. The way we generate the “child” samples is the following: each survived sample is paired with other survivors once, the probability density function of generating offspring at a certain point in parameter space is the sum of two 10-d normal distributions each centered at the parent node with zero correlation between each dimension.
5. Go back to step 2.

The result of the optimization is shown below.

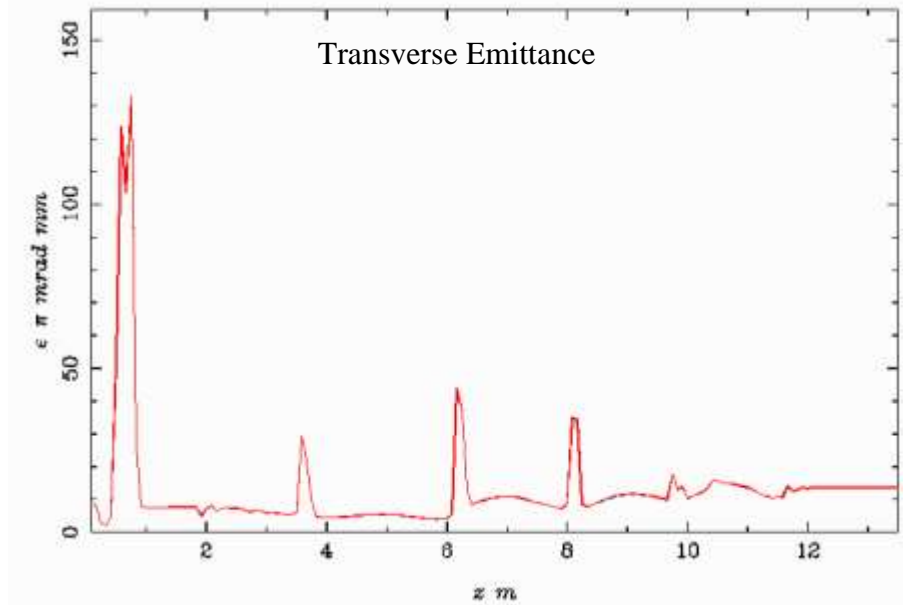


Figure 4-3. Transverse emittance vs. distance from cathode.

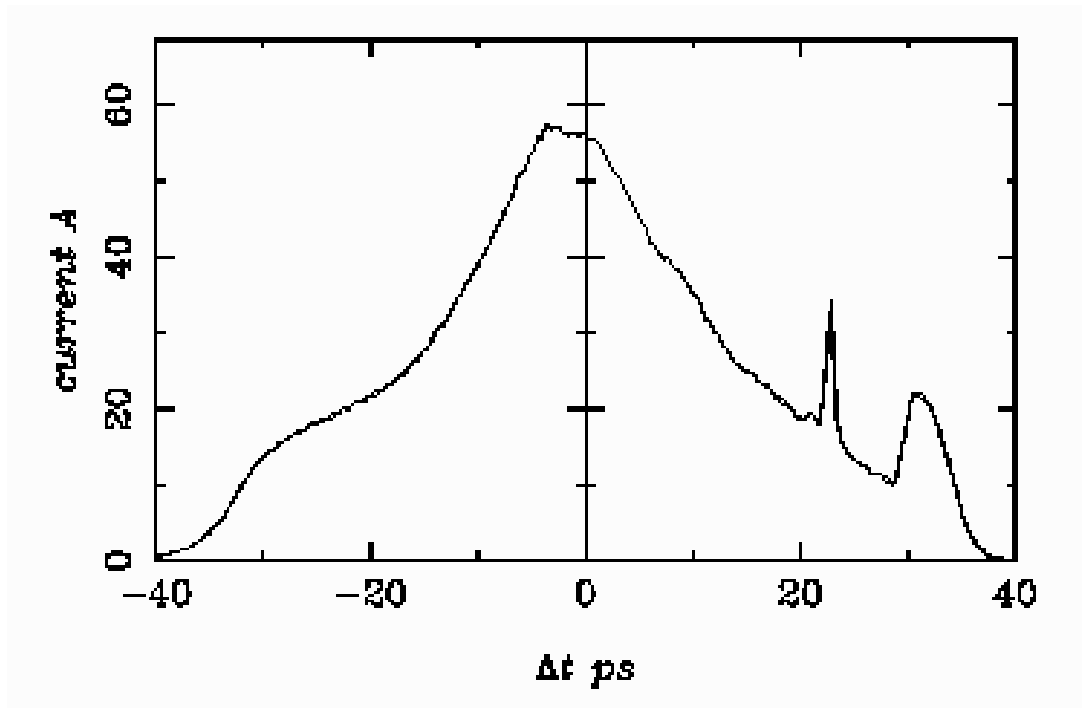


Figure 4-4. Time profile of bunch at the exit of LINAC.

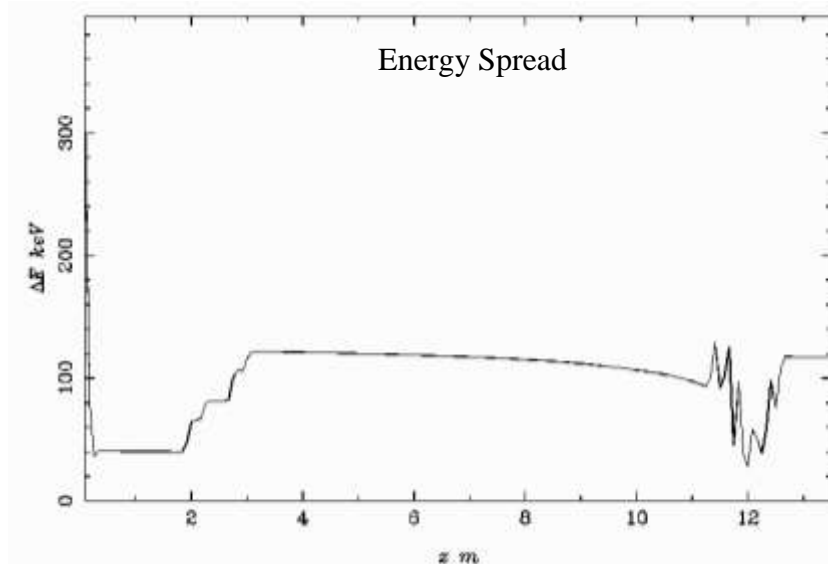


Figure 4-5. RMS energy spread vs. distance from the cathode.

4.3 Summary

The simulation result shows that the transverse emittance containing 95% of electrons was 7.25π mm mrad. The RMS energy spread at the exit of the LINAC is 117 keV, which corresponding to 0.5% of relative energy spread. Finally, the peak current we got here is 55 A. This is the result of balancing the requirement on emittance, energy spread and flat top current. It is possible for a genetic algorithm to be trapped at local minimum. Further modification on the code, such as introducing more mutation between generations or including extra ranking mechanism such as density-based ranking will help the algorithm to escape the local minimum.

5 112MHz SRF Electron Injector Commissioning

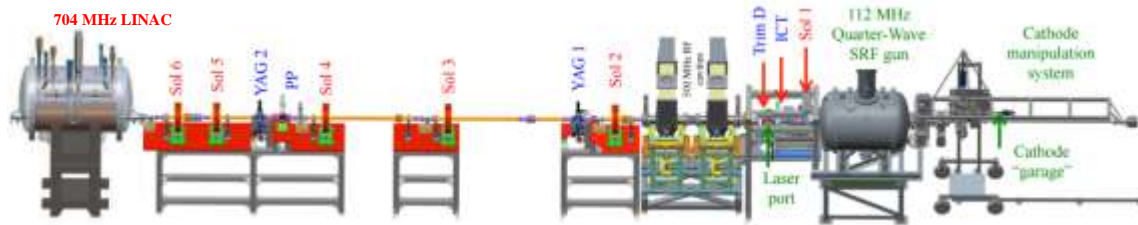


Figure 5-1. The layout of 112 MHz SRF injector (low energy experiment) [87, 88].

The layout of the 112 MHz SRF injector for CEC PoP experiment is shown in Figure 5-1. From the right to left there is: the cathode insertion system discussed in the previous chapter; the 112 MHz QWR SRF gun operating at 4.5 K; the first solenoid acting as the space charge compensation and first focusing; the integrated current transformer (ICT) for bunch charge detection; Trim-D is the trim dipole for energy spread measurement; two 500 MHz bunching cavity; YAG-1 and YAG-2 as beam profile monitor; solenoids 2-6 as beam confining elements; PP is a pepper pot diagnostic for emittance measurement; finally the 704 MHz SRF 5-cell cavity at the LINAC.

5.1 SRF Commissioning

In order to operate the injector at its highest gradient, which is essential to generating designed bunch charge, we need to condition the cavity as well as the FPC for a couple of times. There were several multipacting barriers that occurred during the conditioning as described in previous chapters and all of them were overcome eventually. One of the first tasks in the commissioning is the measurement of the quality factor of the gun cavity as a function of the total gun voltage.

Quality factor measurement

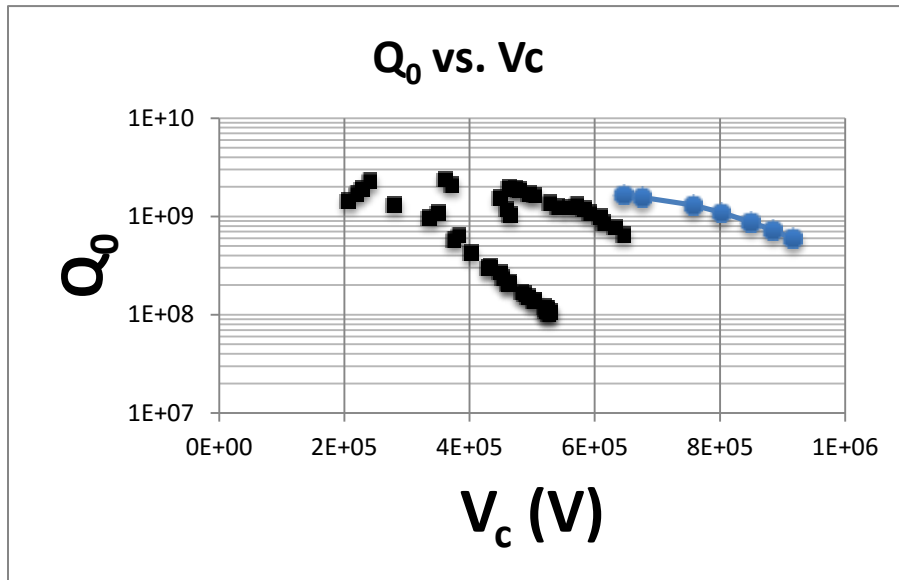


Figure 5-2. Quality factor measurement of the cavity without cathode stalk and FPC.

Figure 5-2 shows the Q_0 measured at Niowave at Feb-20-2013. The black dots show the conditioning process and the blue dots show the results after high power processing.

Figure 5-3 shows the measurement of Q_0 after the installation of cathode stalk and FPC. We can see the cavity quality has not changed by much.

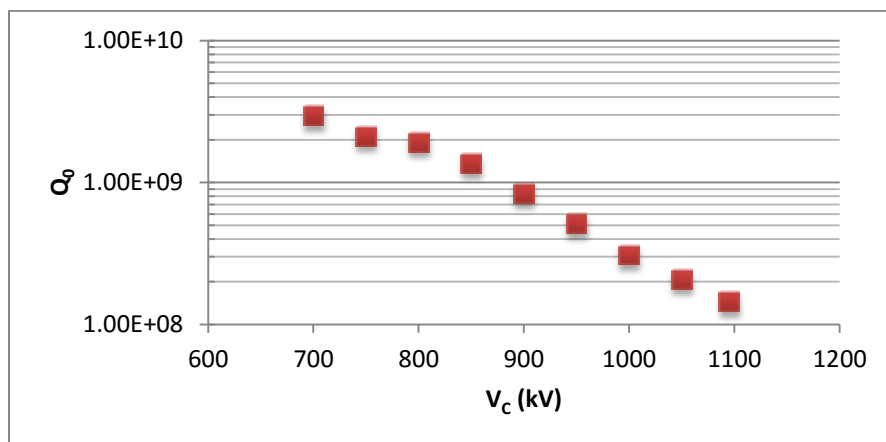


Figure 5-3. Q_0 measured after the installation of FPC and cathode stalk.

Dark Current and Helium Processing

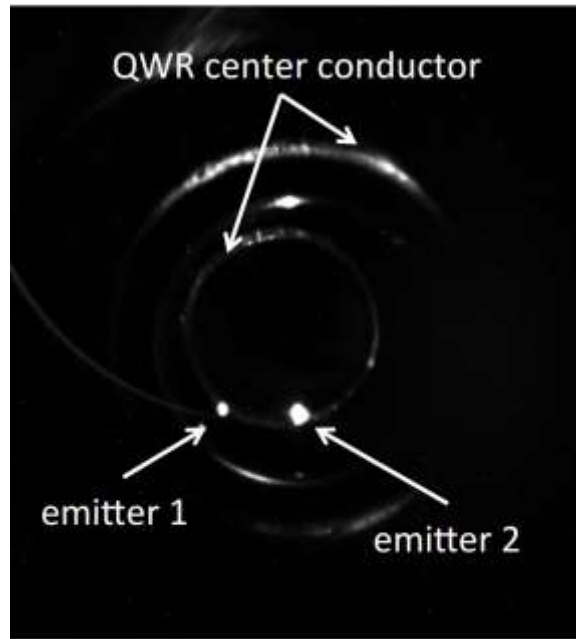


Figure 5-4. Image of field emitter from the cavity.

Once the gun is at voltage, we started looking for the electron beam from field emission (also called “dark current”). After we saw the strong dark current, presumably from the emission tips on the surface of the cavity or the cathode stalk (Figure 5-4) [89], we performed helium processing to the cavity. First, we charge the cavity with helium to 1×10^{-5} Torr. Then we put RF power into the cavity in pulsed mode for half an hour or longer as necessary to clear up the surface of the cavity from field emitting spots. The visible emitters near the cathode stalk tip were removed after the helium processing. Figure 5-5 shows the progress of helium processing. With higher gun voltage the radiation level is decreasing which is a clear indication that the emission centers got conditioned.

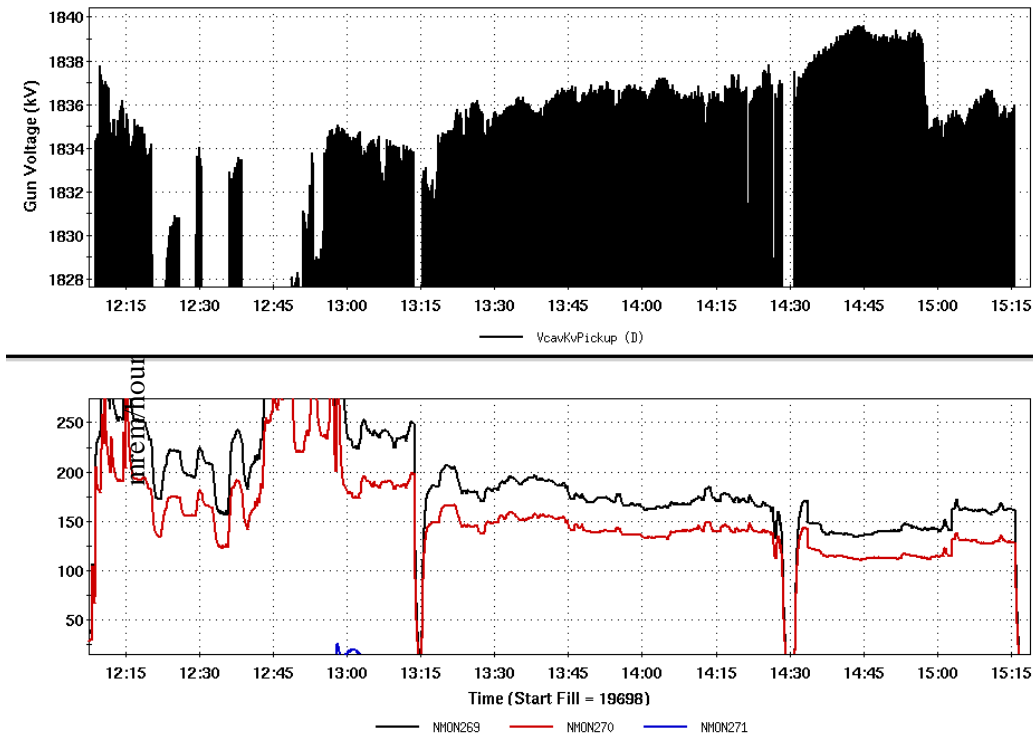


Figure 5-5. Upper plot shows the gun voltage near the end of helium processing, lower plot shows the radiation does decrease.

After the helium processing, the injector was able to operate in CW mode up to 1.7 MV gun voltage in continuous mode and 1.8 MV in pulsed mode.

5.2 Photocurrent Measurement

The cathode was driven by 532 nm green laser, which was introduced into the injector through a laser port and an input mirror. The cathode puck is mirror finished, and the reflectivity of the cathode area on this puck is more than 38%. A significant amount of light reflects from the puck. Therefore, we have another mirror on the opposite location of the input one to guide the reflected beam out of the injector system. Figure 5-6 shows the section view of the cavity with laser cross, FPC, cathode and laser path.

During the first photoelectric current commissioning, we were able to establish CW operation under 1.56 MV gun voltage. The photoemitted beam was observed on the integrated current transformer (ICT) at the exit of the 112 MHz SRF gun.

The initial bunch charge was space charge limited at 1.35 nC under 1.5mm FWHM laser spot size.

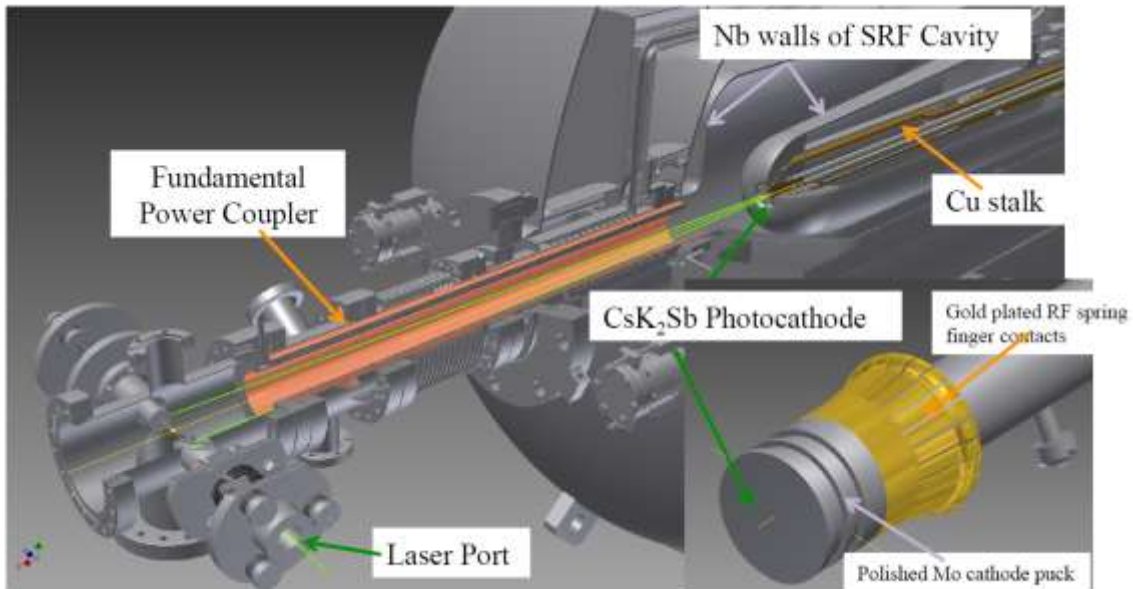


Figure 5-6. The laser path (bright green lines) and details of FPC and cathode in 112 MHz injector [90].

The measured QE was 0.8% which agreed well with our expectation. We could clearly see the space charge limitation on the bunch charge versus laser power plot in Figure 5-7. After we had observed the saturation we increased the laser spot size to 2.5 mm FWHM and generated 2.4 nC (3 nC in maximum) bunch charge as shown Figure 5-8[91]. While operating the laser at a 5 kHz repetition-rate, we were able to generate an average beam current above 15 μ A.

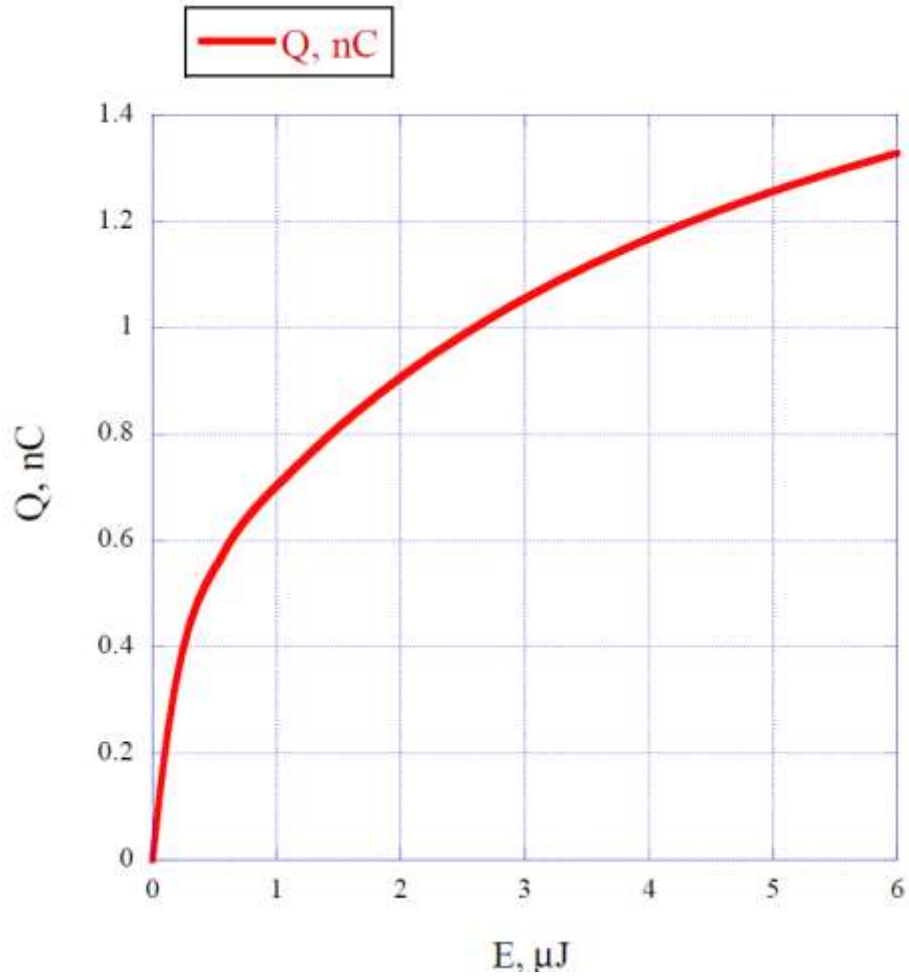


Figure 5-7. Measured charge dependency on laser energy under 1.56 MV gun voltage [91].

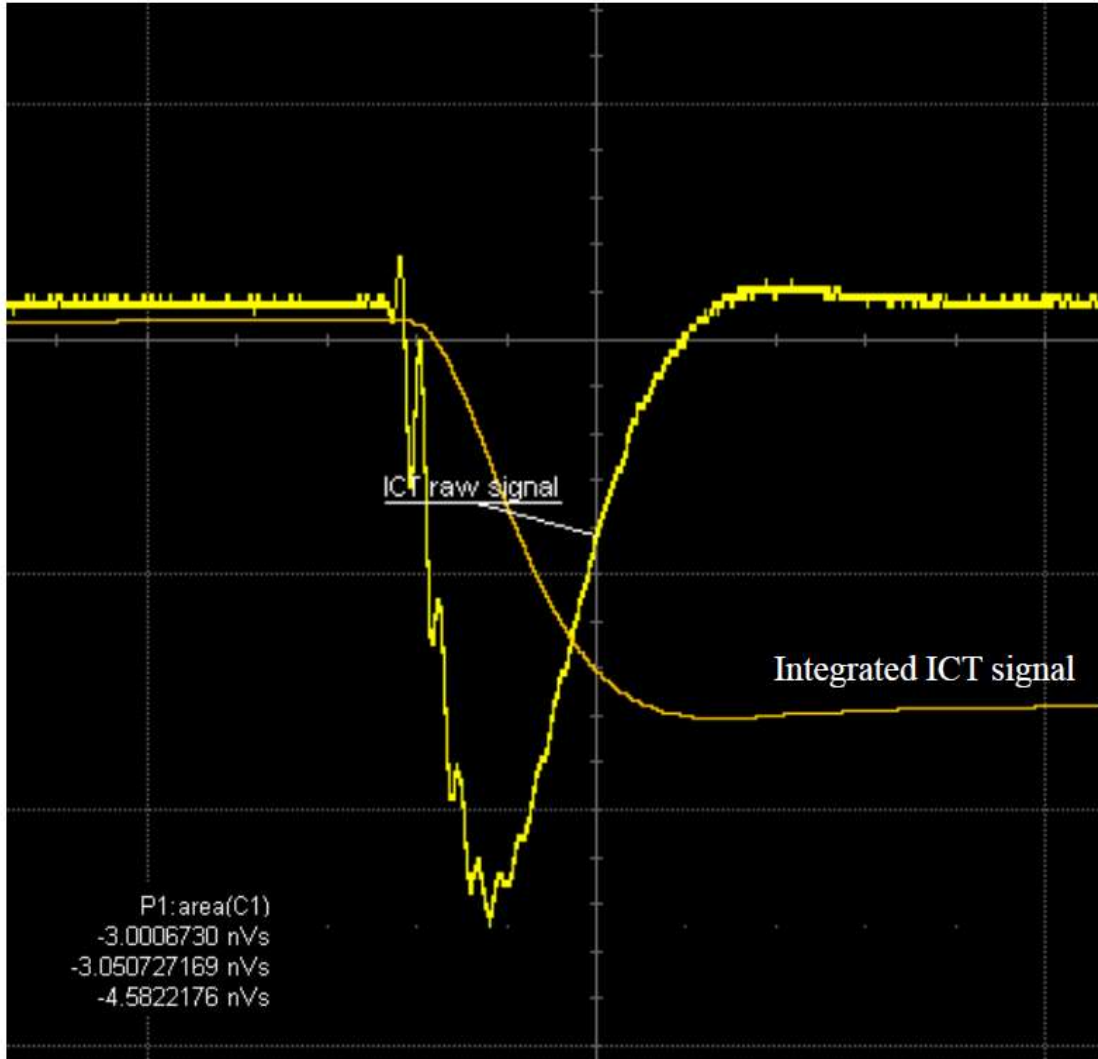


Figure 5-8. Raw and integrated ICT signal. The ICT calibration is 0.8 nC per 1 nV. The signal here corresponding to a 2.4 nC bunch charge [91].

The momentum of the beam is also measured by turning on the vertical trim dipole magnet. The result of the vertical shift of the beam versus current in trim-D is shown in Figure 5-9 which indicates the kinetic energy of electrons equal to 1.6 MeV.

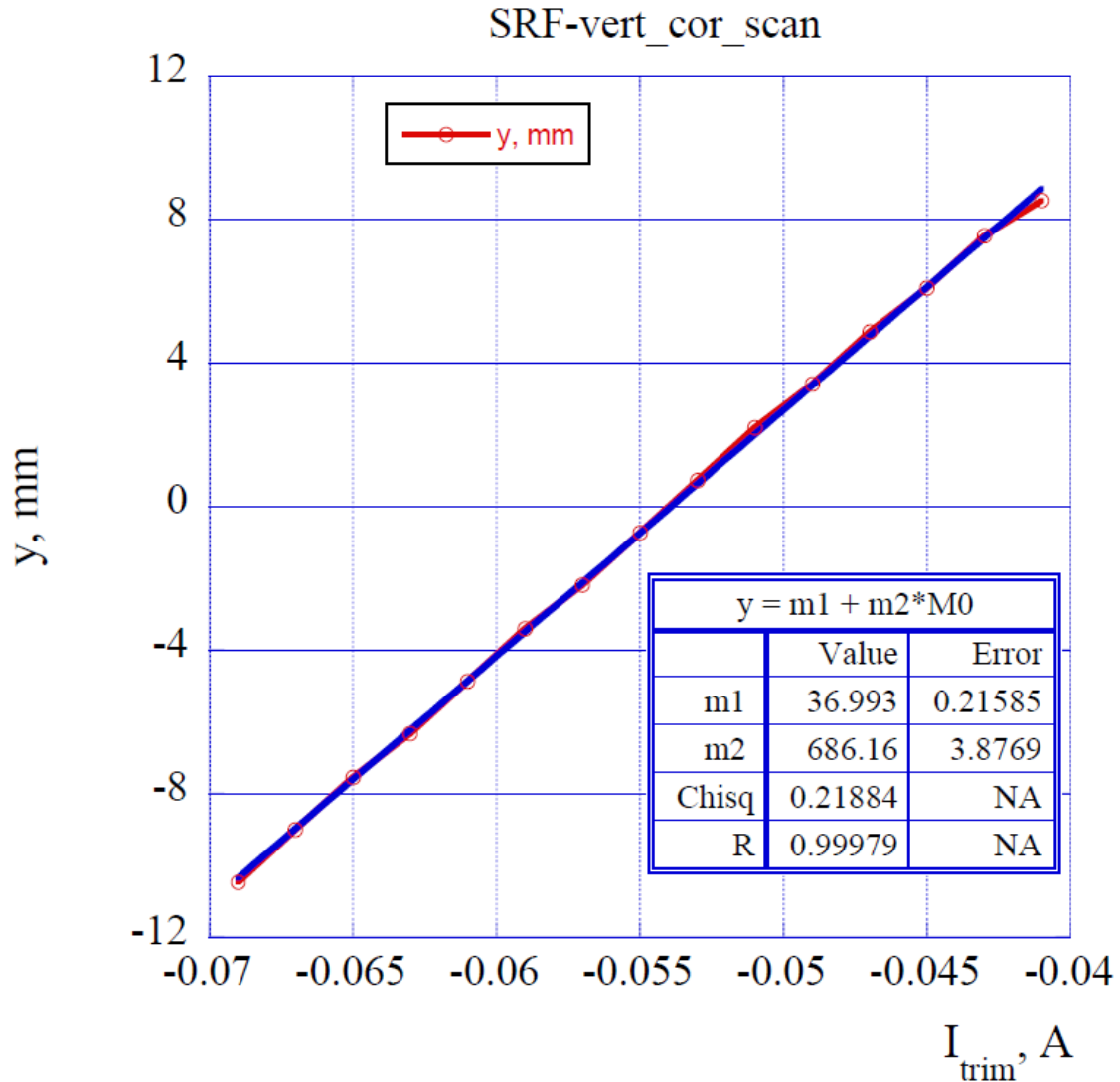


Figure 5-9. Vertical shift of beam position at YAG 1 versus current in Trim D [91].

5.3 Summary

The SRF commissioning of the injector was successful after several iterations. A number of multipacting barriers predicted by our simulation were observed and eventually overcome. The cavity was able to run in CW mode up to 1.7 MV gun voltage after helium processing. Photoemission was successful, and we were able to extract a record 3 nC from single laser pulse with repetition rate 5 kHz. This essentially gives us 15 μ A average current which is also a world record for an SRF photoinjector.

6 Alternative Cathode for the Gun: Diamond Amplifier

The 112 MHz injector is also compatible with other types of photocathodes. Besides the traditional metal or semiconductor cathodes, an interesting alternative is the diamond amplifier. In this chapter we will discuss this relatively new type of cathode that was developed at BNL [92, 93, 94].

6.1 Diamond as Secondary Electron Emitter

The band gap of the CVD diamond we used for this experiment is 5.47 eV which means the bottom of the conduction band is close to the vacuum level [95]. In this case, if we produce a monolayer of hydrogen on the surface of the diamond and form a dipole layer, the vacuum level will be lowered effectively to the point that is below the conduction band on the surface, thus obtaining a negative electron affinity (NEA) surface [96]. When an electron reaches the surface from inside of the diamond, it is very easy for it to escape to the vacuum side.

The conceptual scheme of our experiment on diamond secondary emission in DC system is shown in Figure 6-1. One face of the diamond is coated with 30 nm platinum, which will serve as the electron injection electrode. The other surface of the diamond is hydrogenated as describe in procedure first published in [93]. We use a 10 keV primary electron beam to generate electron-hole (e-h) pairs near the surface of impact. A small portion of the e-h pairs will recombine, and the rest will drift under the external electric field towards opposite surface. The holes will recombine with the injected electron from the platinum electrode [97]. The electrons will drift all the way across the bulk diamond to the hydrogenated surface (we can ignore the small fraction that may be trapped by impurities or defects in the diamond crystal). After the electrons reach the NEA surface, some of the electrons will emit to the vacuum, and some will be trapped on the surface [98]. The trapped electrons will form a shielding field inside the bulk diamond and eventually shut down the drift process. To mitigate this trapping problem, we change the DC high voltage bias to a pulsed signal while keeping the primary electron on all the time. Thus, when the high voltage bias is off the shielding field will act as a drifting field for the holes so that the holes will reach the NEA surface and neutralize the trapped electrons.

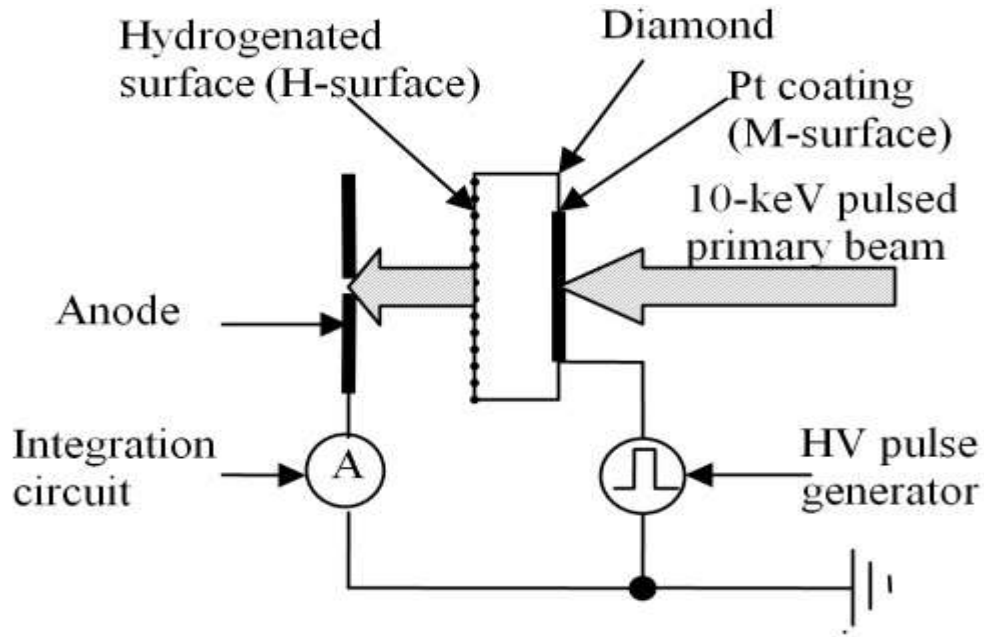


Figure 6-1. Schematic diagram of the diamond amplifier [98].

6.2 Diamond Amplifier for 112 MHz SRF Injector

Instead of using DC bias as the driving field for the secondary electron we would like to use the RF field because of its intrinsic advantages. First, the RF field could be much stronger compared to the state of art DC field. . Another useful feature of the RF field is the sinusoidal behavior in the time domain, which means that the electric field reverses automatically. We can use this as the cleaning field for the neutralization process discussed above.

For the test of the Diamond Amplifier in an SRF gun, we can use the same stalk that was designed for the multi-alkali cathode. As for the source of primary electrons, we decided to use a newly designed DC assembly with a UV-driven copper cathode. A CAD model and a photo of this system are shown in Figure 6-2.

This is the first prototype Diamond Amplifier we made for testing in the SRF gun. There are four major pieces. A gold plated copper top plate is used to hold the diamond and ground it to the cavity. A ceramic spacer serves as an insulator between the grounded top plate and biased molybdenum base. It also acts as a holder for the cathode, and defines the crucial distance between the cathode and diamond. The third part is the cathode/mirror pair that provides the electron beam and guides the laser beam out of the

cavity. The fourth part is the molybdenum base that works as the connection between the Diamond Amplifier and the transport arm.

The laser enters the assembly through a hole in the top plate and illuminates the cathode. There is an aluminum electrode surrounding the cathode, with a shape optimized for focusing the electron beam. After the laser bounces off the mirror-finished cathode, it hits a metal-coated mirror on the other side. This mirror then redirects the laser out of the amplifier through an exit hole in the top plate. Figure 6-3 shows how the amplifier may be positioned in the stalk and cavity as well as the paths of laser and electron beams. The angles of the cathode and mirror are chosen so that the laser beam can escape the cavity with no obstacles, and the electron beam can hit the center of the diamond so that we do not have to worry about charging up of the ceramic spacers. The cathode bias is provided by a -5 kV DC power supply. The top plate is grounded to the cavity through the gold plated fingers.

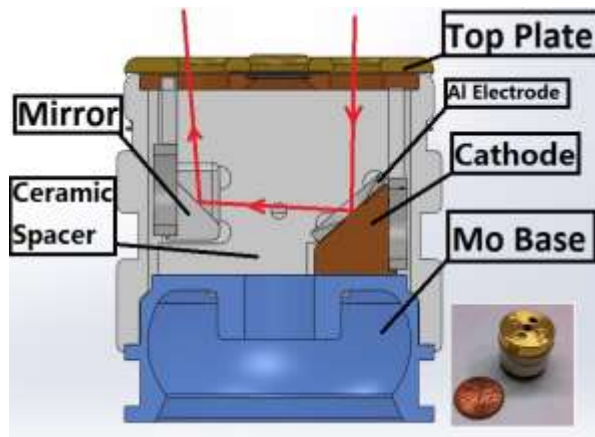


Figure 6-2. Section view of the Diamond Amplifier: red lines show the path of UV light. Small insert is a photo of the first prototype Diamond Amplifier with a penny on the side as a size reference.

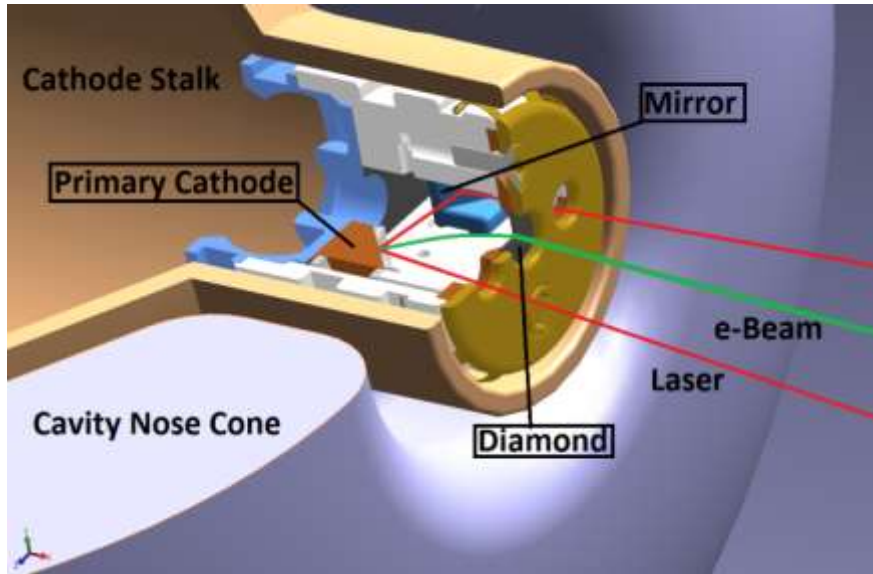


Figure 6-3. Laser path (red) and electron path (green) in the Amplifier and cavity.

To find the optimal orientation of the cathode, we used CST Particle Studio to simulate the trajectory of electron beam after it leaves the cathode. Table 6-1 shows parameters we used in the simulation.

Table 6-1. Parameters for simulation

Parameters	Value
High Voltage	-5 kV
Average Current	5 nA
Pulse width	1 nS
Repetition rate	80 kHz

After a few iterations, the angle between the normal direction of cathode and axis of the cavity is chosen to be 42 degrees. The distance between centers of the cathode and the diamond is optimized to 6.6 mm. Figure 6-4 shows the potential distribution inside the amplifier and the electron beam trajectory. In tests, we were able to guide the primary beam onto the center of Pt coating layer on the back of the diamond. The distance between the center of the beam spot and the center of the diamond was eventually brought down to 180 μm . RF field leakage through the holes in the top plate was taken

into consideration, and we found that the field is low enough that there is no observable effect on the beam energy and position.

We built a prototype Amplifier and made some preliminary measurement on it to demonstrate the feasibility of our design regarding laser and electron beam paths.

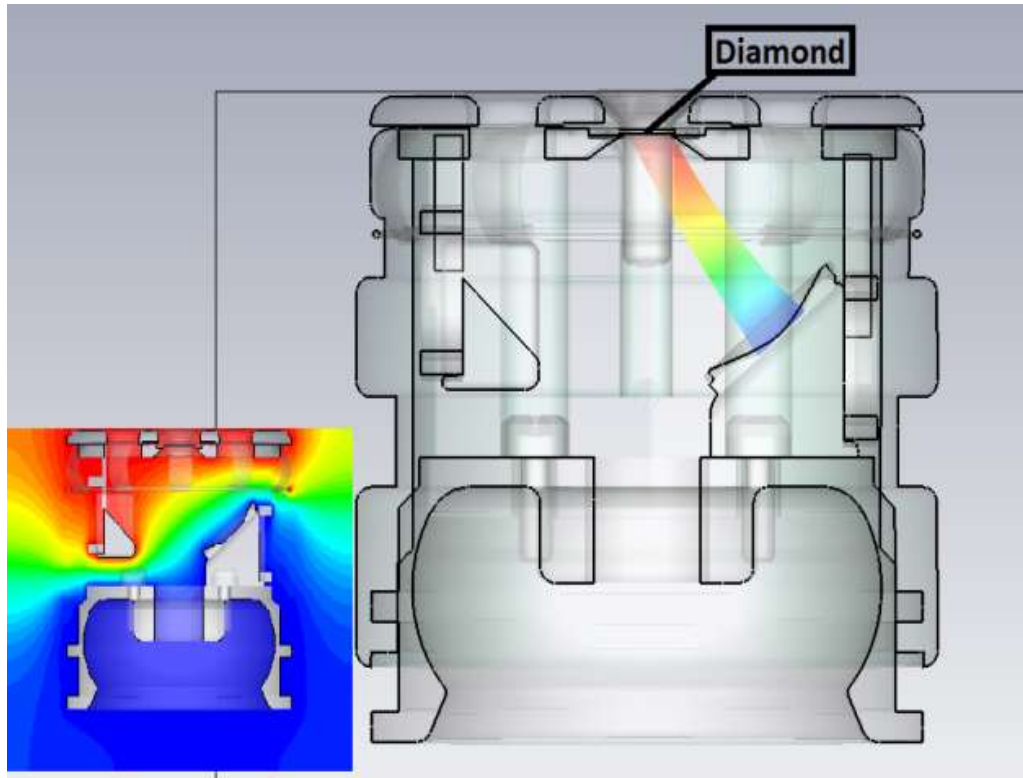


Figure 6-4. Trajectory of electron beam between the primary cathode and diamond. Smaller picture shows the potential distribution inside the Amplifier.

Figure 6-5 shows the test with a green alignment laser. The incoming laser beam passes through a partially reflecting Kapton film window, and then illuminates the copper cathode. After two reflections it comes out of the exit hole on the other side of the top plate. The reflected laser beam from the Kapton window is indicated as a weaker spot.

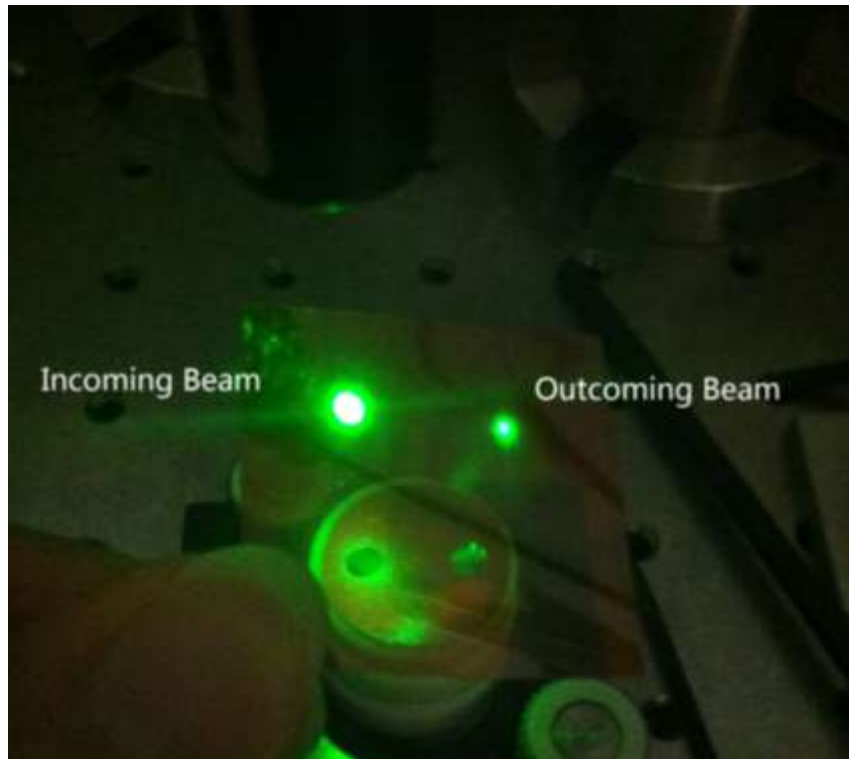


Figure 6-5. Demonstration of the laser beam passage[99].

We also measured the percentage of electrons that we were able to capture with a dummy electrode, which is acting in place of diamond. In this measurement, we successfully applied -5 kV bias to the cathode. Then a 220 nm UV light generated by a deuterium lamp and a monochromator was introduced to the amplifier.

We recorded the current leaving the cathode and the current intercepted by an isolated dummy electrode under different bias voltages. The result of the measurement is shown in Figure 6-6.

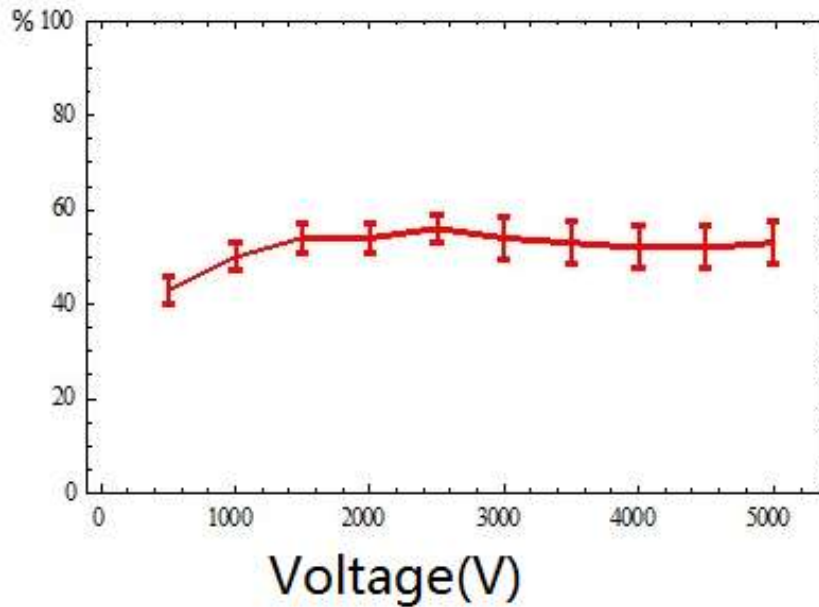


Figure 6-6. Percentage of electrons reaching dummy electrode over electrons leaving cathode.

One can see that about half of the electrons that left the primary cathode did not make it to the dummy electrode. This can be the result of stray light illuminating the cone-shaped electrode sitting on top of the cathode. Since the spot size of UV light from lamp could not be reduced to match exactly the size of the copper cathode, we expect a certain amount of electrons from the aluminum electrode.

Considering the total area of the electrode and the QE of the aluminum, it is possible that nearly half of the signal corresponding to the current leaving cathode was due to the photoemission from aluminum. In future tests, the light source will be changed to a UV laser and the size of the light spot will be sufficiently reduced to minimize the number of electrons caused by stray light.

In future work, we are planning to modify the previous one hundred percent coverage metal coating to a lithographically patterned grid coating. Because the metal layer will reduce the energy of primary electrons, less coverage means larger effective impact energy from primary beam. Hence, the total number of secondary electron product in each pulse will be increased accordingly. The tradeoff is that the weaker electric field established by grid coating inside diamond will drag less secondary electrons to the

emission surface. Figure 6-7 shows the pattern we are planning to use and the coating made from it.

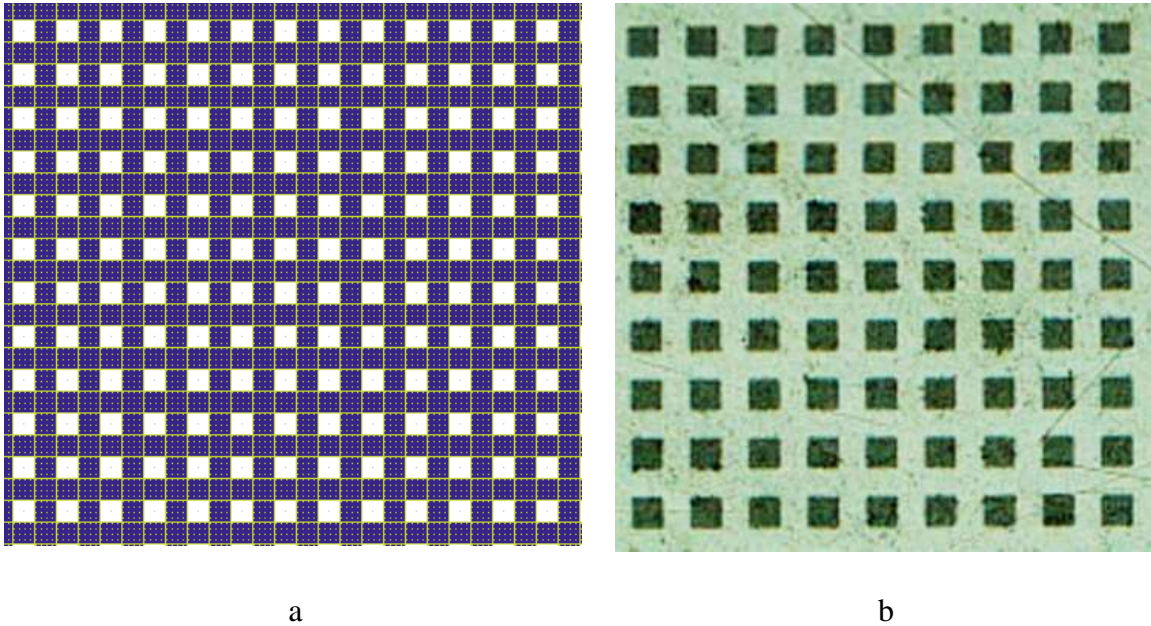


Figure 6-7. (a) Mask used for lithography; (b) Picture of back electrode made with patterned mask. The grid spacing is $50\ \mu\text{m}$ [100].

6.3 Summary

In this chapter, we discussed a very promising alternative photocathode technique, the diamond amplifier. The mechanism of current amplification of diamond is well studied and demonstrated in a DC/Low-frequency mode. To test the amplifier in SRF injector, we designed the housing of the diamond containing the primary electron source. Test of the laser path and primary electron transportation showed very promising results. Further improvement on the electrodes such as the grid type of coating could be used to reduce the energy loss suffered by the primary electrons when they are penetrating the Pt layer.

7 Conclusion

We have presented the design, fabrication, and commissioning of a high-bunch-charge SRF photoemission electron source based on an 112 MHz quarter-wave resonator. The 112 MHz SRF cavity was originally designed for the electron cooling project at BNL and eventually modified to serve as the injector of the Coherent electron Cooling Proof-of-Principle (CeC PoP) project.

The major part of RF design of the cavity was done in previous work. Here we discussed the complementary work for the cavity design including the Lorentz detuning, mechanical detuning sensitivity, and multipacting behavior study. A GPU accelerated C code was written to simulate the multipacting phenomenon in the RF structures such as the cavity, couplers, and waveguides. The code has excellent transferability and can be easily modified to accommodate other similar problems such as the dark current tracking and field emission simulation. By parallelizing the most time-consuming part of the particle tracking algorithm, the coordinates updating and particle locating functions, the GPU code runs on a Nvidia Tesla k40 can give a roughly five times performance boost comparing to the CPU version of the same function running on an Intel i7 4795.

We designed a coaxial fundamental power coupler so that it is compatible with the existing cryomodule and capable of providing up to 780 W beam power with enough safety margins. The coaxial coupler has the advantage of large coupling factor, a sufficient fine-tuning range and minimum dipole kick to the beam. The large coupling range gives us more edge when we need to power through the tough multipacting barriers. Moreover, it potentially allows us to provide more beam power to higher bunch charge beams. Less dipole kick is helpful for reducing the emittance growth. However, the coaxial coupler also has a disadvantage of higher susceptibility to multipacting between the inner and outer conductors. Fortunately, we were able to simulate the MP in the FPC and find the way of mitigating the problem by coating the surface of the inner conductor with gold.

The gun employs high QE multi-alkali (K_2CsSb) photocathodes deposited on small molybdenum pucks. The recipe of cathode deposition has been well developed and adopted by the cathode fabrication group at BNL. We can routinely grow cathodes with

QE better than 5% in the deposition chamber located at the Instrumentation Department at BNL. The cathode preservation requires high vacuum condition, ideally better than 1×10^{-10} Torr. Hence, we designed and built a cathode transport system (nickname ‘garage’) that can take up to three cathodes from the deposition chamber to the 112 MHz injector in the RHIC tunnel while keeping the vacuum under 1×10^{-10} Torr. We also presented the design and test result of a half-wavelength choke structure cathode stalk. The stalk allows the cathode to operate at room temperature so that the QE at the wavelength of 532 nm can be preserved. It also minimizes the voltage drop between the cathode and the cavity because of the choke structure. An impedance mismatch was introduced to the cathode stalk to further minimize the impedance of the choke structure seen by the cavity and consequently reduce the voltage drop in the cathode-cavity gap. Multipacting is an issue of this design, as expected, and we reduced the multiplication of secondary electrons by coating the stalk with gold. This coating also reduces the emissivity of the surface hence reduces the thermal load from radiation to the cryosystem. Simulation results show promising improvement by this surface treatment. However, according to the experimental observation, the multipacting inside the stalk structure still needs excessive conditioning time as compared to the FPC. Further improvement of this issue can be achieved by coating the surface with TiN.

The SRF injector was installed in the RHIC tunnel as part of the CeC PoP experiment. To find the optimum parameters of operation, the author wrote a python script that implements a genetic algorithm to search for the parameter vector that gives the best beam quality. According to the beam dynamics simulation, the injector should be able to provide a beam with emittance around 7.25 mm-mrad and energy spread better than 0.5%. During the first round of commissioning, we managed to overcome multipacting and field emission to a level allowing demonstrating first beam with bunch charge of 3 nC at 5 kHz repetition rate which is the record in such devices.

An alternative cathode, Diamond Amplifier, was also studied intensively. The compatible parts of the amplifier were designed and tested outside the SRF cavity. The result of the preliminary test is promising, and future test in the SRF injector should provide more interesting result.

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